

FOR FLOW AND REFLOW SOLDERING

CHIP MONOLITHIC CERAMIC CAPACITOR GRM SERIES

1.SCOPE

This product specification is applied to CHIP MONOLITHIC CERAMIC CAPACITOR used for General Electronic equipment.

2.MURATA PART NO. SYSTEM

2.1 NEW PART NO.

(EX.)

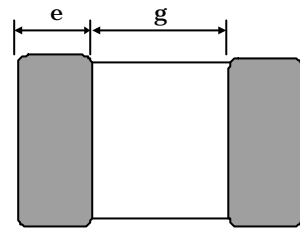
GRM	188	B1	1H	102	K	---	D
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① ② ③ ④ ⑤ ⑥ ⑦ ⑧

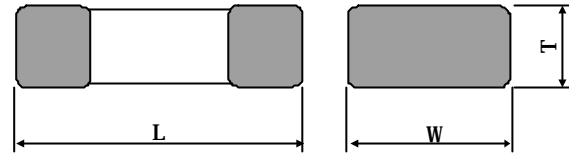
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|-------------------------------|-------------------------|
| ① Type | : According to 3.1 |
| ② Dimensions | : According to 3.1 |
| ③ Temperature Characteristics | : According to 3.2 |
| ④ DC Rated Voltage | : According to 3.3 |
| ⑤ Nominal Capacitance | : According to 3.4 |
| ⑥ Capacitance Tolerance | : According to 3.5 |
| ⑦ Murata's Control | : Murata's Control Code |
| ⑧ Packaging Code | : According to 3.6 |

3.TYPE

3.1 TYPE & DIMENSIONS



Termination : Nickel plated barrier layer
Tin plated



(Unit:mm)

TYPE	L	W	T	e	g
GRM033	0.6+/-0.03	0.3+/-0.03	0.3+/-0.03	0.1 to 0.2	0.2 min.
GRM155	1.0+/-0.05	0.5+/-0.05	0.5+/-0.05	0.15 to 0.35	0.3 min.
GRM188	1.6+/-0.1	0.8+/-0.1	0.8+/-0.1	0.2 to 0.5	0.5 min.
GRM21	2.0+/-0.1	1.25+/-0.1	0.6+/-0.1	0.2 to 0.7	0.7 min.
			0.85+/-0.1		
			1.0+/-0.2		
			1.25+/-0.1		
GRM31	3.2+/-0.15	1.6+/-0.15	0.6+/-0.1	0.3 to 0.8	1.5 min.
			0.85+/-0.1		
			1.15+/-0.1		
	3.2+/-0.2	1.6+/-0.2	1.2+/-0.1		
			1.6+/-0.2		
GRM32	3.2+/-0.3	2.5+/-0.2	0.85 +0.15/-0.05	0.3 min.	1.0 min.
			1.15+/-0.1		
			1.35+/-0.15		
			1.6+/-0.2		
			1.8+/-0.2		
			2.0+/-0.2		
			2.5+/-0.2		
GRM43	4.5+/-0.4	3.2+/-0.3	1.35+/-0.15	0.3 min.	2.0 min.
			1.6+/-0.2		
			1.8+/-0.2		
			2.0+/-0.2		
			2.5+/-0.2		
GRM55	5.7+/-0.4	5.0+/-0.4	1.15+/-0.1	0.3 min.	2.0 min.
			1.35+/-0.15		
			1.6+/-0.2		
			1.8+/-0.2		
			2.0+/-0.2		
			2.5+/-0.2		

1.Thickness dimensions(T) : According to appendix.

2.GRM18 Series Bulk case packaging is L:1.6+/-0.07mm W/T:0.8+/-0.07mm.

3.GRM21 Series B1 0J 335/475K is L:2.0+/-0.15mm W/T:1.25+/-0.15mm.

4.GRM31 Series B3/R1 1E 225K/M, B1/R1 1C 105/155/225K/M, B1 1A 335K/M, B1 0J 475K/M, R7 2A 474/684K/M is L:3.2+/-0.2mm, W:1.6+/-0.2 mm.

3.2 TEMPERATURE CHARACTERISTICS

(1) Temperature Compensating Type

Code	TEMPERATURE CHARACTERISTICS	Temp. Range	Temp. coeff.(ppm/°C)
2C	CH	-55 to 125°C	0 +/-60
3C	CJ		0 +/-120
4C	CK		0 +/-250
5C	C0G		0+/-30
6C	C0H		0+/-60
2P	PH	-25 to 85°C	-150 +/-60
3P	PJ		-150 +/-120
6P	P2H	-55 to 85°C	-150+/-60
2R	RH	-25 to 85°C	-220 +/-60
3R	RJ		-220 +/-120
4R	RK		-220+/-250
6R	R2H	-55 to 85°C	-220+/-60
2S	SH	-25 to 85°C	-330 +/-60
3S	SJ		-330 +/-120
4S	SK		-330+/-250
6S	S2H	-55 to 85°C	-330+/-60
2T	TH	-25 to 85°C	-470 +/-60
3T	TJ		-470 +/-120
4T	TK		-470+/-250
6T	T2H	-55 to 85°C	-470+/-60
3U	UJ	-25 to 85°C	-750 +/-120
4U	UK		-750 +/-250
7U	U2J	-55 to 85°C	-750+/-120
1X	SL	20 to 85°C	+350 to -1000

(2) High Dielectric Constant Type

Code	TEMPERATURE CHARACTERISTICS	Temp. Range	Cap. Change(Within%)	Standard Temp.
B1*	B	-25 to 85°C	+/-10	20°C
B3		-25 to 85°C	+/-10	
R1*	R	-55 to 125°C	+/-15	
F1*	F	-25 to 85°C	+30/-80	
R7	X7R	-55 to 125°C	+/-15	25°C
R6	X5R	-55 to 85°C	+/-15	
C7	X7S	-55 to 125°C	+/-22	
C8	X6S	-55 to 105°C	+/-22	
F5	Y5V	-30 to 85°C	+22/-82	

* : Add 50% of the rated voltage.

3.3 DC RATED VOLTAGE

Code	0J	1A	1C	1E	1H	2A
DC Rated voltage	6.3V	10V	16V	25V	50V	100V

3.4 NOMINAL CAPACITANCE

Nominal Capacitance shall be expressed by three digits. The first two digits represents significant figures. The last specifies the number of zero to follow.

The letter R is used as the decimal point. According to appendix.

(EX.)

Code	Capacitance
R50	0.5pF
5R0	5.0pF
220	22pF
221	220pF

3.5 CAPACITANCE TOLERANCE

Code	Type	Temperature Characteristics	Capacitance Tolerance		Capacitance Step
C	Temperature Compensating Type	ΔC to ΔX	<10pF	+/-0.25pF	0.5,1,2,3,4,5,7(pF)
D				+/-0.5pF	5,6,7,8,9(pF)
R			≥ 10 pF	+/-2.5%	10(pF)
J				+/-5%	E24 Step
K	High Dielectric	B1/B3/R6/R1/R7	+/-10%		E12 Step
M			+/-20%		E6 Step
Z	Constant Type	F1/F5	+80/-20%		

*E24 step is also available for GRM03/15/18 1 to 9.1pF.

E Step

E24	1	1.1	1.2	1.3	1.5	1.6	1.8	2	2.2	2.4	2.7	3	3.3	3.6	3.9	4.3	4.7	5.1	5.6	6.2	6.8	7.5	8.2	9.1
E12	1	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2												
E6	1		1.5		2.2		3.3		4.7		6.8													

3.6 PACKAGING

Packaging is the following method. According to Packaging Methods.

Packaging Code	Specification	Packaging Unit
B	Bulk Packaging in a bag	1000pcs/bag (Only GRM43S,GRM55E/F: 500pcs./bag)
D	$\phi 178$ mm Paper Tape Carrier Packaging	According to Capacitance Value and Tolerance
L	$\phi 178$ mm Plastic Tape Carrier Packaging	
E	$\phi 178$ mm Special Dimension Carrier Packaging	
J	$\phi 330$ mm Paper Tape Carrier Packaging	
K	$\phi 330$ mm Plastic Tape Carrier Packaging	
F	$\phi 330$ mm Special Dimension Carrier Packaging	
C	Bulk Case Packaging	

4.SPECIFICATIONS

Refer to P10 to P13 for Appendix 1 to 3.

Refer to P14 to P16 for Appendix 4.

Refer to P17 to P19 for Appendix 5.

Refer to P20 to P21 for Appendix 6.

Appendix 1. CAPACITANCE VALUE AND TOLERANCE 50V max. <Temperature Compensating Type>

Type	DC RATED VOLTAGE (V)	T		Temperature Characteristics and Capacitance(pF)							φ178 Packaging Unit (pcs/Reel)	
		Code	Thickness (mm)	ΔC	ΔP	ΔR	ΔS	ΔT	ΔU	1X		
GRM03	50	3	0.3+/-0.03	-	-	-	-	-	1 to 15	-	15000	
	25			0.5 to 100	-	1to 100	1to 100	1to 100	16 to 100	-		
GRM15	50	5	0.5+/-0.05	0.5 to 1000	3to 30	3to 33	3to 39	3to 100	3 to 200	0.5 to 200	10000	
	25			180 to 270	-	-	-	-	-	220 to 390		
GRM18	50	8	0.8 +/-0.1	0.5to 2700	3to 160	3to 180	3to 220	3to 470	3 to 750 1000 to 10000	0.5 to 750 1000 to 10000	4000	
	25			560 to 1500	-	-	-	-	-	820 to 1500		
GRM21	50	6	0.6 +/-0.1	0.5 to 4700	3to 160	3to 180	3to 240	3to 130	3 to 1300 10000, 12000, 15000, 18000	0.5 to 1300 10000, 12000, 15000, 18000	4000	
		9	0.85+/-0.1	1000, 5100 to 15000	180 to 360	200 to 470	270 to 470	150 to 390	1500 to 2200 22000 to 27000	1500 to 2200 22000 to 27000		
		A	1.0+0/-0.2	-	-	-	-	-	33000	33000		3000
	25	B	1.25+/-0.1	18000 to 22000	390 to 620	510 to 750	510 to 820	430 to 1800	2400 to 3300 39000 to 47000	2400 to 3300 39000 to 47000	3000	
		9	0.85+/-0.1	-	-	-	-	-	-	3600 to 4700	4000	
		B	1.25+/-0.1	-	-	-	-	-	-	5100 to 6800	3000	
GRM31	50	6	0.6+/-0.1	0.5 to 750	3 to 330	3 to 390	3 to 510	3 to 390	3 to 1800	0.5 to 1800	4000	
		9	0.85+/-0.1	820 to 22000, 27000, 33000	360 to 910	430 to 820	560 to 1100	430 to 750	2000 to 6200 56000	2000 to 6200 56000		
		M	1.15+/-0.1	39000 to 47000	1000 to 1600	910 to 1600	1200 to 2000	820 to 4300	6800 to 8200 68000to100000	6800 to 8200 68000to100000		3000
		C	1.6+/-0.2	56000 to 82000	-	-	-	-	-	-		2000
	25	M	1.15+/-0.1	-	-	-	-	-	-	9100 to 16000	3000	
		C	1.6+/-0.2	100000	-	-	-	-	-	-	2000	
GRM32	50	N	1.35+/-0.15	-	-	-	-	-	-	9100 to 12000	2000	
GRM43	50	R	1.8+/-0.2	-	-	-	-	-	-	13000 to 16000	1000	
GRM55	50	M	1.15+/-0.1	-	-	-	-	-	-	18000	1000	
		N	1.35+/-0.15	-	-	-	-	-	-	20000 to 22000		
		R	1.8+/-0.2	-	-	-	-	-	-	24000 to 39000		
Capacitance Tolerance				(0.5 to 7.0pF) C:+/-0.25pF	(5.0 to 9.1pF) D:+/-0.5pF	(More than 10pF) J:+/-5%	(10pF) R:+/-2.5%					

1.Inner electrode : Nickel ,Palladium or Silver/Palladium

**Appendix 2-1. CAPACITANCE VALUE AND TOLERANCE 50V max.
<High Dielectric Constant Type>**

Type	DC RATED VOLTAGE (V)	T		Temperature Characteristics and Capacitance(pF)						φ178 Packaging Unit (pcs/Reel)
		Code	Thickness (mm)	B1	B3/R6	R1/R7	R7	F1/F5	F5	
GRM03	25	3	0.3+/-0.03	100 to 1500	-	100 to 1500	-	-	-	15000
	16			100 to 1000	1800to3300	100 to 1000, 1800 to 3300	-	-		
	10			1200 to 10000	-	1200 to 10000	-	1500 to 10000		
	6.3			1200 to 10000	-	1200 to 10000	-	-		
GRM15	50	5	0.5+/-0.05	220 to 4700	-	220 to 4700	-	1000 to 15000	-	10000
	25			5600 to 22000	27000 to 47000	5600 to 47000	-	22000 to 100000		
	16			27000 to 47000	56000 to 100000	15000 to 100000	-	33000 to 100000		
	10			56000 to 100000	-	27000 to 47000	-	150000 to 470000		
GRM18	50	8	0.8 +/-0.1	220 to 47000	56000 to 100000	220 to 100000	-	1000 to 220000	-	4000
	25			8200 to 150000	180000 to 220000	8200 to 220000	-	15000 to 100000, 220000 to 470000		
	16			12000 to 330000	390000 to 470000	12000 to 470000	-	33000 to 100000		
	10			120000 to 220000, 330000 to 1000000	470000, 1000000	120000 to 220000	-	470000 to 1000000		
	6.3			330000 to 1000000	-	-	-	-		
GRM21	50	6	0.6+/-0.1	220 to 22000	-	220 to 22000	-	1000 to 68000	-	4000
		9	0.85+/-0.1	27000 to 39000	330000	27000 to 39000	330000	100000 to 150000	470000 to 1000000	
		B	1.25+/-0.1	47000 to 100000	470000	47000 to 100000	150000to 220000	220000	-	
	25	6	0.6+/-0.1	10000 to 33000	-	10000 to 33000	-	33000 to 150000	-	4000
		9	0.85+/-0.1	39000 to 68000, 220000 to 270000	470000, 680000 to 1000000	39000 to 68000, 220000 to 270000, 470000	-	220000,1000000	-	
		B	1.25+/-0.1	82000 to 180000, 330000 to 470000	560000, 1500000	82000 to 180000, 330000 to 820000	-	330000 to 470000, 1500000,4700000	-	
	16	6	0.6+/-0.1	15000 to 56000	-	15000 to 56000	-	100000,220000	-	4000
		9	0.85+/-0.1	68000 to 100000, 220000 to 270000, 470000 to 680000	-	68000 to 100000, 220000 to 270000, 470000 to 680000	-	150000,330000, 470000,1000000	-	
		B	1.25+/-0.1	120000 to 180000, 330000 to 390000, 820000 to1000000	-	120000 to 180000, 330000 to 390000, 820000 to1000000	-	470000 to 680000, 150000 to 2200000	-	
	10	6	0.6+/-0.1	220000 to 390000	-	220000 to 390000	-	330000 to 680000	-	4000
		9	0.85+/-0.1	1000000	-	-	-	1000000,3300000	-	
		B	1.25+/-0.1	680000 to 820000, 1000000,2200000	-	680000 to1000000	-	1500000to 2200000, 4700000	-	
6.3	B	1.25+/-0.1	2200000	-	-	-	-	-	3000	
		1.25+/-0.15	3300000,4700000	-	-	-	-	-		
GRM31	50	6	0.6+/-0.1	220 to 15000	-	220 to 15000	-	1000 to 47000	-	4000
		9	0.85+/-0.1	220 to 100000	-	220 to 100000	270000 to 330000	68000 to 330000	-	
		M	1.15+/-0.1	120000 to 220000	1000000	120000 to 220000	390000 to 470000	470000	-	
		C	1.6+/-0.2	-	1500000, 2200000	-	-	-	-	
	25	6	0.6+/-0.1	18000 to 33000	-	18000 to 33000	-	68000 to 150000	-	4000
		9	0.85+/-0.1	39000 to 150000, 270000 to 680000	-	39000 to 150000, 270000 to 680000	-	220000 to 470000	-	
		M	1.15+/-0.1	180000 to 220000, 820000to1000000	-	180000 to 220000, 820000 to1000000	-	680000 to 4700000	-	
		C	1.6+/-0.2	-	3300000, 4700000	-	-	6800000to10000000	-	
	16	6	0.6+/-0.1	47000 to 56000	-	47000 to 56000	-	220000	-	4000
		9	0.85+/-0.1	68000 to 220000, 330000, 470000 to 560000, 1000000	-	68000 to 220000, 330000, 470000 to 560000, 1000000	-	330000 to 470000, 1000000	-	
		M	1.15+/-0.1	270000, 680000 to 820000	-	270000, 680000 to 820000	-	680000 to 4700000	-	
		C	1.6+/-0.2	1500000, 2200000	-	1500000, 2200000	-	-	-	
10	9	0.85+/-0.1	820000 to 1000000, 2200000, 3300000	-	820000 to 1000000	-	2200000 to 3300000	-	4000	
	M	1.15+/-0.1	-	-	2200000	-	4700000 to 10000000	-		
	C	1.6 +/-0.2	4700000, 10000000	-	10000000	-	-	-		
	M	1.15+/-0.1	4700000	-	-	-	10000000	-		
6.3	C	1.6 +/-0.2	4700000, 10000000	-	-	-	-	-	2000	

Capacitance Tolerance

K:+/-10%, M +/-20%

Z : +80/-20%

1.Inner electrode : Nickel , Palladium , or Silver/Palladium

Appendix 2-2. CAPACITANCE VALUE AND TOLERANCE 50V max.

<High Dielectric Constant Type>

Type	DC RATED VOLTAGE (V)	T		Temperature Characteristics and Capacitance (pF)						φ178 Packaging Unit (pcs/Reel)
		Code	Thickness (mm)	B1	B3/R6	R1/R7	R7	F1/F5	F5	
GRM32	50	M	1.15+/-0.1	390000 to 470000	-	390000 to 470000	-	-	-	3000
		N	1.35+/-0.15	180000 to 220000 560000 to 680000	-	180000 to 220000 560000 to 680000	-	680000	-	2000
		R	1.8 +/-0.2	820000 to 1000000	-	820000 to 1000000	-	1000000	-	1000
		D	2.0+/-0.2	-	3300000	-	-	-	10000000	-
	25	E	2.5+/-0.2	-	-	4700000	-	-	-	1000
		9	0.85+/-0.1	-	-	-	-	4700000	-	4000
		N	1.35+/-0.15	-	-	-	-	1500000	10000000	2000
		R	1.8 +/-0.2	2200000	-	-	2200000	-	-	1000
	16	D	2.0+/-0.2	3300000,4700000	-	3300000,4700000	-	-	-	1000
		M	1.15+/-0.1	2200000	-	2200000	-	-	-	3000
		N	1.35+/-0.15	3300000	-	3300000	-	10000000	-	2000
		R	1.8 +/-0.2	4700000	-	4700000	-	-	-	1000
	10	D	2.0+/-0.2	10000000	10000000	10000000	-	-	-	1000
		9	0.85+/-0.1	-	-	-	-	10000000	-	4000
D		2.0+/-0.2	-	-	-	10000000	-	-	1000	
E		2.5 +/-0.2	10000000	-	-	-	-	-	1000	
GRM43	50	R	1.8 +/-0.2	270000 to 680000	-	270000 to 680000	-	1000000 to 2200000	-	1000
		D	2.0 +/-0.2	-	-	1500000	-	-	-	500
		E	2.5 +/-0.2	-	-	2200000	-	-	-	500
	25	E	2.5 +/-0.2	-	-	4700000	-	-	-	500
GRM55	50	R	1.8 +/-0.2	560000 to 1500000	-	560000 to 1500000	-	3300000 to 4700000	-	1000
		D	2.0+/-0.2	-	10000000	3300000	-	-	-	1000
		E	2.5+/-0.2	-	-	4700000	-	-	-	500
	25	D	2.0+/-0.2	10000000	-	10000000	-	-	-	1000
Capacitance Tolerance				K: +/-10%, M: +/-20%			Z: +80/-20%			

1. Inner electrode : Nickel , Palladium , or Silver/Palladium

Appendix 3. CAPACITANCE VALUE AND TOLERANCE(100V)

Type	DC RATED VOLTAGE (V)	T		Temperature Characteristics and Capacitance				φ178 Packaging Unit (pcs/ Reel)
		Code	Thickness (mm)	Temperature Compensating Type		High Dielectric Constant Type		
				ΔC	1X	R7	F5	
GRM15	100	5	0.5+/-0.05	-	-	220 to 4700	-	10000
GRM18	100	8	0.8+/-0.1	0.5 to 1000	0.5 to 430	220 to 3300, 100000	1500 to 4700	4000
GRM21	100	6	0.6+/-0.1	100 to 560	-	-	-	4000
		9	0.85+/-0.1	0.5 to 91, 620 to 1500	0.5 to 750	220 to 6800	680 to 6800	4000
		B	1.25+/-0.1	-	820 to 2000	8200 to 47000	10000 to 22000	3000
GRM31	100	9	0.85+/-0.1	0.5 to 5600	0.5 to 1800	220 to 15000, 100000	1000 to 22000	4000
		M	1.15+/-0.1	-	2000 to 4700	18000 to 82000 150000, 220000	33000 to 47000	3000
			1.15+/-0.15	-	-	470000, 680000	-	
		C	1.6+/-0.2	-	-	1000000	-	2000
GRM32	100	M	1.15+/-0.1	-	-	47000	68000	3000
		N	1.35+/-0.15	-	5100 to 6800	56000 to 100000	68000 to 100000	2000
		C	1.6+/-0.2	-	-	680000, 1000000	-	2000
		D	2.0+/-0.2	-	-	1500000	-	1000
		E	2.5+/-0.2	-	-	1000000, 2200000	-	1000
GRM43	100	N	1.35+/-0.15	-	7500 to 8200	-	-	
		R	1.8+/-0.2	6200 to 12000	9100 to 16000	120000 to 220000	150000 to 330000	1000
		D	1.6+/-0.2	-	-	390000 to 470000 1500000	-	500
GRM55	100	E	2.5+/-0.2	-	-	2200000	-	500
		M	1.15+/-0.1	-	18000	-	-	
		N	1.35+/-0.15	13000 to 16000	20000 to 22000	270000	-	
		R	1.8+/-0.2	18000 to 30000	24000 to 39000	330000 to 560000	470000 to 680000	1000
		D	1.6+/-0.2	-	-	820000 to 1000000 3300000	-	500
E	2.5+/-0.2	-	-	4700000	-	500		
Capacitance Tolerance				(0.5 to 5.0pF) C: +/-0.25pF (5.1 to 9.1pF) D: +/-0.5pF (More than 10pF) J: +/-5%		K: +/-10% M: +/-20%		Z: +80/-20%

1. Inner electrode : Nickel , Palladium , or Silver/Palladium

Appendix 4. CAPACITANCE VALUE

Type	DC RATED VOLTAGE (V)	T		Temperature Characteristics and Capacitance (μF)							$\phi 178$ Packaging Unit (pcs/Reel)	
		Code	Thickness (mm)	B1	B3/R6	R7	R1/R7	C8	C7	F1/F5		
GRM03	6.3	3	0.3+/-0.03	0.015 to 0.033	0.047 to 0.10	-	-	-	-	-	15000	
GRM15	10	5	0.5+/-0.05	-	0.15 to 1.0	-	-	-	-	0.22 to 1.0	10000	
	6.3			0.15 to 0.33	0.47, 1.0	-	-	-	-	1.0		
GRM18	16	8	0.8+/-0.1	-	1.0	-	-	-	-	-	4000	
	25			-	0.47, 1.0	-	-	-	-	-		
	16			-	0.47, 1.0, 2.2	-	-	-	1.0	-		
	10			-	2.2	-	-	-	1.0	2.2, 4.7		
	6.3			2.2	2.2, 4.7	-	-	-	2.2	2.2, 4.7		
	4			-	-	-	-	-	4.7	2.2		-
GRM21	25	6	0.6+/-0.1	-	1.0	-	-	-	-	-	4000	
		B	1.25+/-0.15	-	2.2, 3.3, 4.7	2.2	-	-	-	-	3000	
	16	6	0.6+/-0.1	-	1.0	-	-	-	-	-	4000	
		9	0.85+/-0.1	-	2.2	-	-	-	-	-	4000	
	10	B	1.25+/-0.1	-	2.2, 3.3, 4.7	-	-	-	-	-	3000	
		6	0.6+/-0.1	1.0	2.2	-	-	-	-	-	4000	
		9	0.85+/-0.1	2.2	3.3, 4.7	-	-	-	-	-	4000	
		B	1.25+/-0.1	-	10	-	-	-	-	-	3000	
	6.3	B	1.25+/-0.15	-	3.3, 4.7	-	-	-	3.3, 4.7	-	3000	
		9	0.85+/-0.1	4.7	4.7, 10	-	-	-	-	-	4000	
		B	1.25+/-0.1	10	10	-	-	-	-	10	3000	
		B	1.25+/-0.15	-	22	-	-	-	-	-	3000	
6		0.6+/-0.1	-	2.2	-	-	-	-	-	4000		
9		0.85+/-0.1	-	4.7	-	-	-	-	-	2000		
GRM31	16	6	0.6+/-0.1	-	2.2	-	-	-	-	-	4000	
		9	0.85+/-0.1	-	4.7	-	-	-	-	-	4000	
	10	6	0.6+/-0.1	-	3.3, 4.7	-	-	-	-	-	4000	
		9	0.85+/-0.1	4.7	10	-	-	-	-	-	3000	
		M	1.15+/-0.1	-	10	-	-	-	-	-	2000	
		C	1.6+/-0.2	-	-	-	-	-	22	-	4000	
	6.3	9	0.85+/-0.1	10	10	-	-	-	-	-	3000	
		M	1.15+/-0.1	-	10	-	-	-	-	-	2000	
		C	1.6+/-0.2	-	15, 22, 47	-	-	-	-	22	1000	
		E	2.5+/-0.2	-	22	-	-	-	-	-	2000	
	GRM32	16	C	1.6+/-0.2	-	-	-	-	-	-	22	1000
			E	2.5+/-0.2	-	22, 47	-	-	-	-	-	2000
10		N	1.35+/-0.15	-	22	-	-	-	-	-	1000	
		C	1.6+/-0.2	-	-	-	-	-	-	22	1000	
		E	2.5+/-0.2	22	47	-	22	-	-	-	1000	
6.3		D	2.0+/-0.2	22	33	-	-	-	-	-	1000	
		E	2.5+/-0.2	-	47, 100	-	-	-	-	100	1000	
		E	2.5+/-0.2	-	-	-	-	100	-	-	1000	
GRM43	16	E	2.5+/-0.2	22	-	-	-	-	-	-	500	
		D	2.0+/-0.2	-	33	-	-	-	-	-	1000	
	6.3	E	2.5+/-0.2	22	47	-	22	-	-	-	500	
		D	2.0+/-0.2	33	-	-	-	-	-	-	1000	
		E	2.5+/-0.2	47	-	-	-	-	-	-	500	
GRM55	6.3	S	2.8+/-0.2	-	100	-	-	-	-	-	500	
		F	3.2+/-0.2	100	-	-	-	-	-	-	300	
Capacitance Tolerance				K : +/-10% Not apply to (GRM21BB3/R60J226M GRM21BB3/R60G226M GRM31CB3/R60J476M GRM32DB3/R60J336M GRM32EB3/R60J476M GRM32EB3/R60J107M GRM32EC80G107M GRM43SB3/R60J107M) M : +/-20%							Z : +80/-20%	

Appendix 5. CAPACITANCE VALUE

No	MURATA New P/N	SIZE(mm)		T(mm)	T.C.	DC RATED VOLTAGE (V)	CAP.		CAP.TOL.
		L	W						
1	GRM 31M F5 1C 106 Z A12 L	3.2	1.6	1.15+/-0.1	F5	16	10	μF	+80/-20%

No	MURATA New P/N	CUSTOMER P/N	φ178 PACKAGING Q'TY (pcs/Reel)
1	GRM 31M F5 1C 106 Z A12 L		3000

1. Inner electrode : Nickel, Palladium, or Silver/Palladium.

Appendix 6. CAPACITANCE VALUE

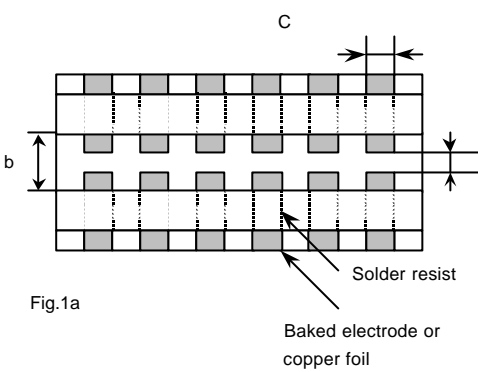
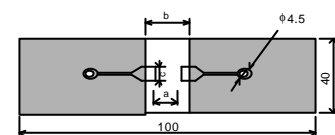
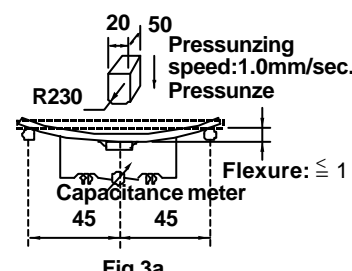
No	MURATA New P/N	SIZE(mm)		T(mm)	T.C.	DC RATED VOLTAGE (V)	CAP.		CAP.TOL.
		L	W						
1	GRM 188 R6 0J 106 ME47 D	1.6	0.8	0.8+/-0.1	R6	6.3	10	μF	+/-20%

No	MURATA New P/N	CUSTOMER P/N	φ178 PACKAGING Q'TY (pcs/Reel)
1	GRM 188 R6 0J 106 ME47 D		4000

1. Inner electrode : Nickel, Palladium, or Silver/Palladium.

SPECIFICATIONS AND TEST METHODS

No	Item	Specification		Test Method																					
		Temperature Compensating Type	High Dielectric Constant Type																						
1	Operating Temperature Range	ΔC,1X:-55°C to 125°C Other :-25°C to 85°C	B1,B3,F1 :-25°C to 85°C R1,R7 :-55°C to 125°C R6 :-55°C to 85°C C8 :-55°C to 105°C F5 :-30°C to 85°C	Standard Temperature : 20 °C (R6,R7,C8,F5 : 25 °C)																					
2	Rated Voltage	See the previous pages.		The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V^{P-P} or V^{O-P} , whichever is larger, shall be maintained within the rated voltage range.																					
3	Appearance	No defects or abnormalities.		Visual inspection.																					
4	Dimension	Within the specified dimensions. .		Using calipers. (GRM02 size is based on Microscope)																					
5	Dielectric Strength	No defects or abnormalities.		No failure shall be observed when 300% of the rated voltage (temperature compensating type) or 250% of the rated voltage (high dielectric constant type) is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.																					
6	Insulation Resistance	$C \geq 0.047\mu F$: More than 10000MΩ $C > 0.047\mu F$: 500Ω · F C:Nominal Capacitance		The insulation resistance shall be measured with a DC voltage not exceeding the rated voltage at 20°C /25°C and 75%RH max. and within 2 minutes of charging, provided the charge/discharge current is less than 50mA.																					
7	Capacitance	Within the specified tolerance.		The capacitance/D.F. shall be measured at 20°C /25°C at the frequency and voltage shown in the table.																					
8	Q/Dissipation Factor (D.F.)	30pF and over: $Q \geq 1000$ 30pF and below: $Q \geq 400+20C$ C:Nominal Capacitance (pF)	[B1,B3,R1,R6,R7,C8] W.V.:100V: 0.025max.(C< 0.068μF) : 0.05max.(C≥ 0.068μF) W.V.:25/50V :0.025max. W.V.:16/10V :0.035max. W.V.:6.3V/4V :0.05max.(C<3.3μF) :0.1max.(C≥ 3.3μF) [F1,F5] W.V.:25Vmin :0.05max.(C<0.1μF) :0.09max.(C ≥ 0.1μF) W.V.:16/10V:0.125max. W.V.:6.3V:0.15max.	<table border="1"> <thead> <tr> <th>Char.</th> <th>ΔC to 3U,1X (1000pF and below)</th> <th>ΔC to 3U,1X (more than 1000pF)</th> </tr> </thead> <tbody> <tr> <td>Item</td> <td></td> <td>B1,R1,R6,R7,F1,F5</td> </tr> <tr> <td>Frequency</td> <td>1±0.1MHz</td> <td>1±0.1kHz</td> </tr> <tr> <td>Voltage</td> <td>0.5 to 5Vrms</td> <td>1±0.2Vrms</td> </tr> </tbody> </table>	Char.	ΔC to 3U,1X (1000pF and below)	ΔC to 3U,1X (more than 1000pF)	Item		B1,R1,R6,R7,F1,F5	Frequency	1±0.1MHz	1±0.1kHz	Voltage	0.5 to 5Vrms	1±0.2Vrms									
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Frequency	1±0.1MHz	1±0.1kHz																							
Voltage	0.5 to 5Vrms	1±0.2Vrms																							
9	Capacitance Temperature Characteristics	No bias	Within the specified tolerance.(Table A-1)	The capacitance change shall be measured after 5min. at each specified temp.stage. (1)Temperature Compensating Type The temperature coefficient is determined using the capacitance measured in step 3 as a reference. When cycling the temperature sequentially from step 1 through 5 (+20°C to +125°C:other temp.coeffs.:+20°C to +85°C) the capacitance shall be within the specified tolerance for the temperature coefficient and capacitance change as Table A-1. The capacitance drift is calculated by dividing the differences between the maximum and minimum measured values in the step 1,3 and 5 by the cap.value in step 3.																					
		50% of the rated voltage			<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>20±2</td> </tr> <tr> <td>2</td> <td>-55±3(for ΔC)/-25±3(for other TC)</td> </tr> <tr> <td>3</td> <td>20±2</td> </tr> <tr> <td>4</td> <td>125±3(for ΔC)/85±3(for other TC)</td> </tr> <tr> <td>5</td> <td>20±2</td> </tr> </tbody> </table>	Step	Temperature(°C)	1	20±2	2	-55±3(for ΔC)/-25±3(for other TC)	3	20±2	4	125±3(for ΔC)/85±3(for other TC)	5	20±2								
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Capacitance Drift	Within±0.2% or±0.05pF (Whichever is larger.) *Not apply to 1X/25V		(2) High Dielectric Constant Type The ranges of capacitance change compared with the 20°C value over the temperature ranges shown in the table shall be within the specified ranges.* In case of applying voltage, the capacitance change shall be measured after 1 more min. with applying voltage in equilibration of each temp. stage.																						
			<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> <th>Applying voltage(V)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>20±2/25±2</td> <td rowspan="3">No bias</td> </tr> <tr> <td>2</td> <td>-55±3(for R1,R7,R6,C8)/ -25±3(for B1,B3,F1)/ -30±3(for F5)</td> </tr> <tr> <td>3</td> <td>20±2/25±2</td> </tr> <tr> <td>4</td> <td>125±3(for R1,R7)/ 105±3(for C8) 85±3(for B1,B3,R6.,F1,F5)</td> <td rowspan="4">50% of the rated voltage</td> </tr> <tr> <td>5</td> <td>20±2</td> </tr> <tr> <td>6</td> <td>-55±3(for R1)/ -25±3(for B1,F1)</td> </tr> <tr> <td>7</td> <td>20±2</td> </tr> <tr> <td>8</td> <td>125±3(for R1)/ 85±3(for B1,F1)</td> <td></td> </tr> </tbody> </table>	Step	Temperature(°C)	Applying voltage(V)	1	20±2/25±2	No bias	2	-55±3(for R1,R7,R6,C8)/ -25±3(for B1,B3,F1)/ -30±3(for F5)	3	20±2/25±2	4	125±3(for R1,R7)/ 105±3(for C8) 85±3(for B1,B3,R6.,F1,F5)	50% of the rated voltage	5	20±2	6	-55±3(for R1)/ -25±3(for B1,F1)	7	20±2	8	125±3(for R1)/ 85±3(for B1,F1)	
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			*Initial measurement for high dielectric constant type Perform a heat treatment at 150 ±0/-10°C for one hour and then set for 48±4 hours at room temperature. Perform the initial measurement.																						

No	Item	Specification		Test Method																																								
		Temperature Compensating Type	High Dielectric Constant Type																																									
10	Adhesive Strength of Termination	No removal of the terminations or other defect shall occur.  <p>Fig.1a</p>		Solder the capacitor on the test jig (glass epoxy board) shown in Fig.1a using an eutectic solder. Then apply 10N* force in parallel with the test jig for 10±1sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. *1N(GRM02),2N(GR□03),5N(GR□15,GRM18) (in:mm)																																								
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11	Vibration Resistance	Appearance No defects or abnormalities.	Capacitance Within the specified tolerance.	Solder the capacitor on the test jig (glass epoxy board) in the same manner and under the same conditions as (10). The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions(total of 6 hours).																																								
		Q/D.F. 30pF and over: $Q \geq 1000$ 30pF and below: $Q \geq 400+20C$ C:Nominal Capacitance (pF)	[B1,B3,R1,R6,R7,C8] W.V.:100V: 0.025max.(C< 0.068μF) : 0.05max.(C≥ 0.068μF) W.V.:25/50V :0.025max. W.V.:16/10V :0.035max. W.V.:6.3V/4V :0.05max. (C<3.3μF) :0.1max.(C≥ 3.3μF) [F1,F5] W.V.:25Vmin :0.05max. (C <0.1μF) :0.09max. (C= 0.1μF) W.V.:16/10V:0.125max. W.V.:6.3V:0.15max.																																									
12	Deflection	No crack or marked defect shall occur.		Solder the capacitor on the test jig (glass epoxy board) shown in Fig.2a using an eutectic solder. Then apply a force in the direction shown in Fig 3a for 5±1 sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.																																								
		 <p>Fig.2</p> <p>t : 1.6mm</p>		(GRP15,GRM18 : t:0.8mm)																																								
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13	Solderability of Termination	75% of the terminations is to be soldered evenly and continuously.		Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion) . Preheat at 80 to 120 ° for 10-to 30 seconds. After preheating, immerse in an eutectic solder solution for 2±0.5 seconds at 230±5°C.																																								

No	Item	Specification		Test Method
		Temperature Compensating Type	High Dielectric Constant Type	
17	Humidity Load	The measured and observed characteristics shall satisfy the specifications in the following table.		Apply the rated voltage at 40±2°C and 90 to 95% humidity for 500±12 hours. Remove and set for 24±2 hours (temperature compensating type) or 48±4 hours (high dielectric constant type) at room temperature, then measure. The charge/discharge current is less than 50mA. -Initial measurement for F1/10Vmax. Apply the rated DC voltage for 1 hour at 40±2°C. Remove and set for 48±4 hours at room temperature. Perform initial measurement.
	Appearance	No defects or abnormalities.		
	Capacitance Change	Within ±7.5% or ±0.75pF (Whichever is larger)	B1,B3,R1,R6,F7,C8: Within ±12.5% F1,F5 : Within ±30% [W.V.:10Vmax.] F1 : Within +30/-40%	
	Q/D.F.	30pF and over: $Q \geq 200$ 30pF and below: $Q \geq 100+10C/3$ C: Nominal Capacitance (pF)	[B1,B3,R1,R6,R7,C8] W.V.:100V: 0.05max. (C < 0.068μF) : 0.075max. (C ≥ 0.068μF) W.V.:25/50V : 0.05max. W.V.:16/10V : 0.05max. W.V.:6.3V:0.075max. (C < 3.3μF) :0.125max. (C ≥ 3.3μF) [F1,F5] W.V.:25Vmin :0.075max. (C < 0.1μF) :0.125max. (C ≥ 0.1μF) W.V.:16/10V:0.15max. W.V.:6.3V:0.2max.	
I.R.	More than 500MΩ or 25Ω·F (Whichever is smaller)			
18	High Temperature Load	The measured and observed characteristics shall satisfy the specifications in the following table.		Apply 200% of the rated voltage at The maximum operating temperature ±3 for 1000±12 hours. Set for 24±2 hours (temperature compensating type) or 48±4 hours (high dielectric constant type) at room temperature, then measure. The charge/discharge current is less than 50mA. -Initial measurement for high dielectric constant type. Apply 200% of the rated DC voltage at the maximum operating temperature ±3°C for one hour. Remove and set for 48±4 hours at room temperature. Perform initial measurement.
	Appearance	No defects or abnormalities.		
	Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)	B1B3,R1,R6,R7,C8: Within ±12.5% F1,F5 : Within ±30% [Except 10Vmax and C = 1.0 μF] F1,F5 : Within +30/-40% [10Vmax and C ≥ 1.0μF]	
	Q/D.F.	30pF and over: $Q \geq 350$ 10pF and over: $Q \geq 275+2.5C$ 10pF and below: $Q \geq 200+10C$ C: Nominal Capacitance (pF)	[B1,B3,R1,R6,R7,C8] W.V.:100V: 0.05max. (C < 0.068μF) : 0.075max. (C ≥ 0.068μF) W.V.:25/50V : 0.04max. W.V.:16/10V : 0.05max. W.V.:6.3V/4V:0.075max. (C < 3.3μF) :0.125max. (C ≥ 3.3μF) [F1,F5] W.V.:25Vmin :0.075max. (C < 0.1μF) :0.125max. (C ≥ 0.1μF) W.V.:16/10V:0.15max. W.V.:6.3V:0.2max.	
I.R.	More than 1,000MΩ or 50Ω·F (Whichever is smaller)			

Table A-1

Char.	Nominal Values (ppm/) Note 1	Capacitance Change from 20°C (%)					
		-55		-25		-10	
		Max.	Min.	Max.	Min.	Max.	Min.
2C	0± 60	0.82	-0.45	0.49	-0.27	0.33	-0.18
3C	0±120	1.37	-0.90	0.82	-0.54	0.55	-0.36
4C	0±250	2.56	-1.88	1.54	-1.13	1.02	-0.75
2P	-150± 60	-	-	1.32	0.41	0.88	0.27
3P	-150±120	-	-	1.65	0.14	1.10	0.09
4P	-150±250	-	-	2.36	-0.45	1.57	-0.30
2R	-220± 60	-	-	1.70	0.72	1.13	0.48
3R	-220±120	-	-	2.03	0.45	1.35	0.30
4R	-220±250	-	-	2.74	-0.14	1.83	-0.09
2S	-330± 60	-	-	2.30	1.22	1.54	0.81
3S	-330±120	-	-	2.63	0.95	1.76	0.63
4S	-330±250	-	-	3.35	0.36	2.23	0.24
2T	-470± 60	-	-	3.07	1.85	2.05	1.23
3T	-470±120	-	-	3.40	1.58	2.27	1.05
4T	-470±250	-	-	4.12	0.99	2.74	0.66
3U	-750±120	-	-	4.94	2.84	3.29	1.89
4U	-750 250	-	-	5.65	2.25	3.77	1.50
1X	+350 -1000	-	-	-	-	-	-

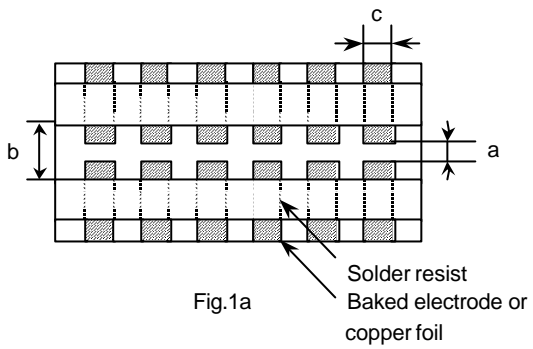
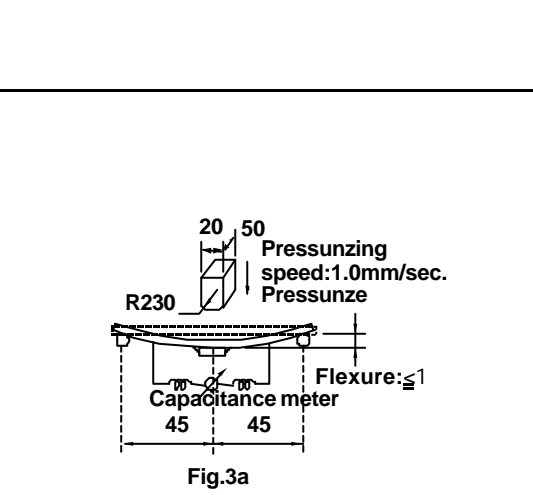
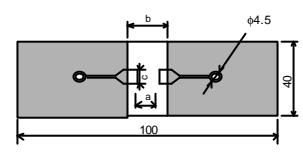
Table A-2

Char.	Nominal Values (ppm/°C) Note 1	Capacitance Change from 25 °C (%)					
		-55		-30		-10	
		Max	Min	Max	Min	Max	Min
5C	0+ 30	0.58	-0.24	0.40	-0.17	0.25	-0.11
6C	0+ 60	0.87	-0.48	0.59	-0.33	0.38	-0.21
6P	-150+ 60	2.33	0.72	1.61	0.50	1.02	0.32
6R	-220+ 60	3.02	1.28	2.08	0.88	1.32	0.56
6S	-330+ 60	4.09	2.16	2.81	1.49	1.79	0.95
6T	-470+ 60	5.46	3.28	3.75	2.26	2.39	1.44
7U	-750+120	8.78	5.04	6.04	3.47	3.84	2.21

Note 1: Nominal values denote the temperature coefficient within a range of 25 °C to 125°C (for ΔC)/85°C (for other TC).

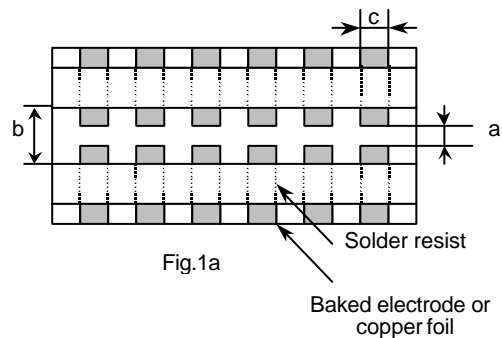
SPECIFICATIONS AND TEST METHODS

No	Item	Specification	Test Method																										
1	Operating Temperature Range	B1,B3,F1,F5 : -25°C to 85°C R1,R7: -55°C to 125°C C6,R6: -55°C to 85°C C7: -55°C to 125°C C8: -55°C to 105°C	Standard Temperature : 20°C (R6,R7,C6,C7,C8,F5 : 25°C)																										
2	Rated Voltage	See the previous pages.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V^{P-P} or V^{O-P} , whichever is larger, shall be maintained within the rated voltage range.																										
3	Appearance	No defects or abnormalities.	Visual inspection.(GRM02 size is based on Microscope)																										
4	Dimension	Within the specified dimensions. .	Using calipers.																										
5	Dielectric Strength	No defects or abnormalities.	No failure shall be observed when 250% of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.																										
6	Insulation Resistance	More than 50Ω · F	The insulation resistance shall be measured with a DC voltage not exceeding the rated voltage at Standard Temperature and 75%RH max. and within 1 minutes of charging, provided the charge/discharge current is less than 50mA.																										
7	Capacitance	Within the specified tolerance. *Table 1 <table border="1" style="margin-left: auto; margin-right: auto;"> <tr><td>GRM155 B3/R6 1A 124 to 105</td></tr> <tr><td>GRM185 B3/R6 1C/1A 105</td></tr> <tr><td>GRM188 B3/R6 1C/1A 225</td></tr> <tr><td>GRM219 B3/R6 1A 475</td></tr> <tr><td>GRM21B B3/R6 1C/1A 106</td></tr> <tr><td>GRM319 B3/R6 1A 106</td></tr> </table>	GRM155 B3/R6 1A 124 to 105	GRM185 B3/R6 1C/1A 105	GRM188 B3/R6 1C/1A 225	GRM219 B3/R6 1A 475	GRM21B B3/R6 1C/1A 106	GRM319 B3/R6 1A 106	The capacitance shall be measured at Standard Temperature at the frequency and voltage shown in the table. <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Capacitance</th> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>*1 $C \leq 10\mu\text{F}$ (10V min)</td> <td>1+/-0.1kHz</td> <td>1.0+/-0.2Vrms</td> </tr> <tr> <td>$C \leq 10\mu\text{F}$ (6.3V max.)</td> <td>1+/-0.1kHz</td> <td>0.5+/-0.1Vrms</td> </tr> <tr> <td>$C > 10\mu\text{F}$</td> <td>120+/-24Hz</td> <td>0.5+/-0.1Vrms</td> </tr> </tbody> </table> *1 However the Voltage is 0.5+/-0.1Vrms about Table 1 items on the left side.	Capacitance	Frequency	Voltage	*1 $C \leq 10\mu\text{F}$ (10V min)	1+/-0.1kHz	1.0+/-0.2Vrms	$C \leq 10\mu\text{F}$ (6.3V max.)	1+/-0.1kHz	0.5+/-0.1Vrms	$C > 10\mu\text{F}$	120+/-24Hz	0.5+/-0.1Vrms								
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8	Dissipation Factor (D.F.)	B1,B3,R1,R6,R7,C7,C8 : 0.1 max. C6 : 0.125 max F1,F5 : 0.2 max *Table 1 <table border="1" style="margin-left: auto; margin-right: auto;"> <tr><td>GRM155 B3/R6 1A 124 to 105</td></tr> <tr><td>GRM185 B3/R6 1C/1A 105</td></tr> <tr><td>GRM188 B3/R6 1C/1A 225</td></tr> <tr><td>GRM219 B3/R6 1A 475</td></tr> <tr><td>GRM21B B3/R6 1C/1A 106</td></tr> <tr><td>GRM319 B3/R6 1A 106</td></tr> </table>	GRM155 B3/R6 1A 124 to 105	GRM185 B3/R6 1C/1A 105	GRM188 B3/R6 1C/1A 225	GRM219 B3/R6 1A 475	GRM21B B3/R6 1C/1A 106	GRM319 B3/R6 1A 106	The D.F. shall be measured at Standard Temperature at the Frequency and voltage shown in the table. <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Capacitance</th> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>*1 $C \leq 10\mu\text{F}$ (10V min)</td> <td>1+/-0.1kHz</td> <td>1.0+/-0.2Vrms</td> </tr> <tr> <td>$C \leq 10\mu\text{F}$ (6.3V max.)</td> <td>1+/-0.1kHz</td> <td>0.5+/-0.1Vrms</td> </tr> <tr> <td>$C > 10\mu\text{F}$</td> <td>120+/-24Hz</td> <td>0.5+/-0.1Vrms</td> </tr> </tbody> </table> *1 However the Voltage is 0.5+/-0.1Vrms about Table 1 items on the left side.	Capacitance	Frequency	Voltage	*1 $C \leq 10\mu\text{F}$ (10V min)	1+/-0.1kHz	1.0+/-0.2Vrms	$C \leq 10\mu\text{F}$ (6.3V max.)	1+/-0.1kHz	0.5+/-0.1Vrms	$C > 10\mu\text{F}$	120+/-24Hz	0.5+/-0.1Vrms								
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9	Capacitance Temperature Characteristics	<table style="width: 100%;"> <tr> <td style="width: 30%;">No bias</td> <td>B1,B3 : Within +/-10% (-25°C to +85°C) R1,R7 : Withn ±15% (-55°C to +125°C) F1,F5 : Within +30/-80% (-25°C to +85°C) R6 : Within +/-15% (-55°C to +85°C) C6 : Within +/-22% (-55°C to +85°C) C7 : Within +/-22% (-55°C to +125°C) C8 : Within +/-22% (-55°C to +105°C)</td> </tr> <tr> <td>50% of the rated voltage</td> <td>B1: Within +10/-30% R1: Within +15/-40% F1: Within +30/-95%</td> </tr> </table>	No bias	B1,B3 : Within +/-10% (-25°C to +85°C) R1,R7 : Withn ±15% (-55°C to +125°C) F1,F5 : Within +30/-80% (-25°C to +85°C) R6 : Within +/-15% (-55°C to +85°C) C6 : Within +/-22% (-55°C to +85°C) C7 : Within +/-22% (-55°C to +125°C) C8 : Within +/-22% (-55°C to +105°C)	50% of the rated voltage	B1: Within +10/-30% R1: Within +15/-40% F1: Within +30/-95%	<p>The capacitance change shall be measured after 5min. at each specified temp.stage. The ranges of capacitance change compared with the Standard Temperature value over the temperature ranges shown in the table shall be within the specified ranges.* In case of applying voltage, the capacitance change shall be measured after 1 more min. with applying voltage in equilibration of each temp. stage.</p> <p>*GRM43 B1/R6 0J/1A 336/476 only : 1.0±0.2Vrms</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> <th>Applying voltage(V)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>20+/-2 *</td> <td rowspan="3">No bias</td> </tr> <tr> <td>2</td> <td>-55+/-3(for R1,R6,R7,C6,C7,C8) -25+/-3(for B1,B3,F1,F5)</td> </tr> <tr> <td>3</td> <td>20+/-2 *</td> </tr> <tr> <td>4</td> <td>85+/-3(for B1,B3,F1,F5,R6,C6) 125+/-3(for R1,R7,C7) 105+/-3(for C8)</td> <td rowspan="2">* R6,C7,C8 : 25+/-2°C</td> </tr> <tr> <td>5</td> <td>20+/-2</td> </tr> <tr> <td>6</td> <td>-55±3(for R1) -25+/-3(for B1,F1,F5)</td> <td rowspan="3">50% of the rated voltage</td> </tr> <tr> <td>7</td> <td>20+/-2</td> </tr> <tr> <td>8</td> <td>125±3(for R1) 85±3(for B1,F1,F5)</td> </tr> </tbody> </table> <p>*Initial measurement for high dielectric constant type Perform a heat treatment at 150 +0/-10°C for one hour and then set for 48±4 hours at room temprature. Perform the initial measurement.</p>	Step	Temperature(°C)	Applying voltage(V)	1	20+/-2 *	No bias	2	-55+/-3(for R1,R6,R7,C6,C7,C8) -25+/-3(for B1,B3,F1,F5)	3	20+/-2 *	4	85+/-3(for B1,B3,F1,F5,R6,C6) 125+/-3(for R1,R7,C7) 105+/-3(for C8)	* R6,C7,C8 : 25+/-2°C	5	20+/-2	6	-55±3(for R1) -25+/-3(for B1,F1,F5)	50% of the rated voltage	7	20+/-2	8	125±3(for R1) 85±3(for B1,F1,F5)
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10	Adhesive Strength of Termination	<p>No removal of the terminations or other defect shall occur.</p> 	<p>Solder the capacitor on the test jig (glass epoxy board) shown in Fig.1a using an eutectic solder. Then apply 10N* force in parallel with the test jig for 10+/-1sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p> <p>*1N : GR□02,2N : GR□03,5N : GR□15/GRM18,</p> <table border="1"> <thead> <tr> <th>Type</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr><td>GRM02</td><td>0.2</td><td>0.56</td><td>0.23</td></tr> <tr><td>GR□03</td><td>0.3</td><td>0.9</td><td>0.3</td></tr> <tr><td>GR□15</td><td>0.4</td><td>1.5</td><td>0.5</td></tr> <tr><td>GRM18</td><td>1.0</td><td>3.0</td><td>1.2</td></tr> <tr><td>GRM21</td><td>1.2</td><td>4.0</td><td>1.65</td></tr> <tr><td>GRM31</td><td>2.2</td><td>5.0</td><td>2.0</td></tr> <tr><td>GRM32</td><td>2.2</td><td>5.0</td><td>2.9</td></tr> <tr><td>GRM43</td><td>3.5</td><td>7.0</td><td>3.7</td></tr> <tr><td>GRM55</td><td>4.5</td><td>8.0</td><td>5.6</td></tr> </tbody> </table>	Type	a	b	c	GRM02	0.2	0.56	0.23	GR□03	0.3	0.9	0.3	GR□15	0.4	1.5	0.5	GRM18	1.0	3.0	1.2	GRM21	1.2	4.0	1.65	GRM31	2.2	5.0	2.0	GRM32	2.2	5.0	2.9	GRM43	3.5	7.0	3.7	GRM55	4.5	8.0	5.6
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12	Deflection	<p>No crack or marked defect shall occur.</p> 	<p>Solder the capacitor on the test jig (glass epoxy board) shown in Fig.2a using an eutectic solder. Then apply a force in the direction shown in Fig 3a for 5+/-1 sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p>  <p>Fig.2 t : 1.6mm</p> <p>(GRM02,GR□03/15 : t:0.8mm)</p> <table border="1"> <thead> <tr> <th>Type</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr><td>GRM02</td><td>0.2</td><td>0.56</td><td>0.23</td></tr> <tr><td>GR□03</td><td>0.3</td><td>0.9</td><td>0.3</td></tr> <tr><td>GR□15</td><td>0.4</td><td>1.5</td><td>0.5</td></tr> <tr><td>GRM18</td><td>1.0</td><td>3.0</td><td>1.2</td></tr> <tr><td>GRM21</td><td>1.2</td><td>4.0</td><td>1.65</td></tr> <tr><td>GRM31</td><td>2.2</td><td>5.0</td><td>2.0</td></tr> <tr><td>GRM32</td><td>2.2</td><td>5.0</td><td>2.9</td></tr> <tr><td>GRM43</td><td>3.5</td><td>7.0</td><td>3.7</td></tr> <tr><td>GRM55</td><td>4.5</td><td>8.0</td><td>5.6</td></tr> </tbody> </table> <p>(in mm)</p>	Type	a	b	c	GRM02	0.2	0.56	0.23	GR□03	0.3	0.9	0.3	GR□15	0.4	1.5	0.5	GRM18	1.0	3.0	1.2	GRM21	1.2	4.0	1.65	GRM31	2.2	5.0	2.0	GRM32	2.2	5.0	2.9	GRM43	3.5	7.0	3.7	GRM55	4.5	8.0	5.6
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13	Solderability of Termination	<p>75% of the terminations is to be soldered evenly and continuously.</p>	<p>Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion) . Preheat at 80 to 120°C for 10-to 30 seconds. After preheating, immerse in an eutectic solder solution for 2+/-0.5 seconds at 230+/-5°C.</p>																																								

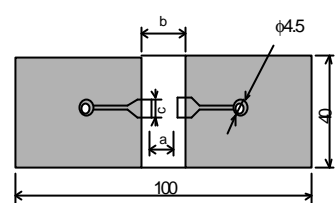
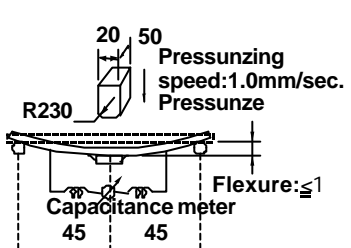
No	Item	Specification		Test Method															
14	Resistance to Soldering Heat	Appearance	No defects or abnormalities.	<p>Preheat the capacitor at 120 to 150°C for 1 minute. Immerse the capacitor in an eutectic solder solution at 270+/-5°C for 10+/-0.5 seconds. Set at room temperature for 24+/-2 hours (temperature compensating type) or 48+/-4 hours (high dielectric constant type), then measure.</p> <p>*GRM02- Soldering method: Reflow Soldering Solder type: SnAgCu</p> <p>· Initial measurement for high dielectric constant type Perform a heat treatment at 150+0/-10°C for one hour and then set at room temperature for 48+/-4 hours. Perform the initial measurement.</p> <p>*Preheating for GRM32/43/55</p> <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature</th> <th>Time</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>100°C to 120°C</td> <td>1 min.</td> </tr> <tr> <td>2</td> <td>170°C to 200°C</td> <td>1 min.</td> </tr> </tbody> </table>	Step	Temperature	Time	1	100°C to 120°C	1 min.	2	170°C to 200°C	1 min.						
		Step	Temperature		Time														
		1	100°C to 120°C		1 min.														
		2	170°C to 200°C		1 min.														
		Capacitance Change	B1,B3,R1,R6,R7,C6,C7,C8: Within +/-7.5% F1,F5 : Within +/-20%																
		Q/D.F.	B1,B3,R1,R6,R7,C7,C8: 0.1 max. C6 : 0.125 max F1,F5 : 0.2 max																
I.R.	More than 50Ω · F																		
Dielectric Strength	No defects .																		
15	Temperature Sudden Change	Appearance	No defects or abnormalities.	<p>Fix the capacitor to the supporting jig in the same manner and under the same conditions as (10). Perform the five cycles according to the four heat treatments shown in the following table. Set for 24+/-2 hours (temperature compensating type) or 48+/-4 hours (high dielectric constant type) at room temperature, then measure.</p> <table border="1"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> </tr> </thead> <tbody> <tr> <td>Temp. (°C)</td> <td>Min. Operating Temp.+0/-3</td> <td>Room Temp.</td> <td>Max. Operating Temp.+3/-0</td> <td>Room Temp.</td> </tr> <tr> <td>Time (min)</td> <td>30+/-3</td> <td>2 to 3</td> <td>30+/-3</td> <td>2 to 3</td> </tr> </tbody> </table> <p>· Initial measurement for high dielectric constant type Perform a heat treatment at 150 +0/-10°C for one hour and then set at room temperature for 48+/-4 hours. Perform the initial measurement.</p>	Step	1	2	3	4	Temp. (°C)	Min. Operating Temp.+0/-3	Room Temp.	Max. Operating Temp.+3/-0	Room Temp.	Time (min)	30+/-3	2 to 3	30+/-3	2 to 3
		Step	1		2	3	4												
		Temp. (°C)	Min. Operating Temp.+0/-3		Room Temp.	Max. Operating Temp.+3/-0	Room Temp.												
		Time (min)	30+/-3		2 to 3	30+/-3	2 to 3												
		Capacitance Change	B1,B3,R1,R6,R7,C6,C7,C8: Within +/-7.5% F1,F5 : Within +/-20%																
		Q/D.F.	B1,B3,R1,R6,R7,C7,C8: 0.1 max. C6 : 0.125 max F1,F5 : 0.2 max																
I.R.	More than 50Ω · F																		
Dielectric Strength	No defects .																		
16	High Temperature High Humidity (Steady)	Appearance	No defects or abnormalities.	<p>Apply the rated voltage at 40+/-2°C and 90 to 95% humidity for 500+/-12 hours. The charge/discharge current is less than 50mA.</p> <p>· Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then let sit for 48+/-4 hours at room temperature. Perform the initial measurement.</p> <p>· Measurement after test Perform a heat treatment at 150+0/-10 °C for one hour and then let sit for 48+/-4 hours at room temperature, then measure.</p>															
		Capacitance Change	B1,B3,R1,R6,R7,C6,C7,C8: Within +/-12.5% F1,F5 : Within +/-30%																
		Q/D.F.	B1,B3,R1,R6,R7,C6,C7,C8: 0.2 max. F1,F5 : 0.4 max																
		I.R.	More than 12.5Ω · F																
17	Durability	Appearance	No defects or abnormalities.	<p>Apply 150% of the rated voltage for 1000+/-12 hours at the maximum operating temperature +/-3°C. Let sit for 48+/-4 hours at room temperature, then measure. The charge/ discharge current is less than 50mA.</p> <p>· Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then let sit for 48+/-4 hours at room temperature. Perform the initial measurement.</p> <p>· Measurement after test Perform a heat treatment at 150+0/-10°C for one hour and then let sit for 48+/-4 hours at room temperature, then measure.</p>															
		Capacitance Change	B1,B3,R1,R6,R7,C6,C7,C8: Within +/-12.5% F1,F5 : Within +/-30%																
		Q/D.F.	B1,B3,R1,R6,R7,C6,C7,C8: 0.2max. F1,F5 : 0.4max																
		I.R.	More than 25Ω · F																

No	Item	Specification	Test Method										
1	Operating Temperature Range	R7/C7 :-55°C to +125°C R6 :-55°C to +85°C F5 :-30°C to +85°C	Standard Temperature:25 °C										
2	Rated Voltage	See the previous pages.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V^{P-P} or V^{OP} , whichever is larger, shall be maintained within the rated voltage range.										
3	Appearance	No defects or abnormalities.	Visual inspection.										
4	Dimension	Within the specified dimensions.	Using calipers.										
5	Dielectric Strength	No defects or abnormalities.	No failure shall be observed when 250% of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.										
6	Insulation Resistance	$C \leq 0.047\mu F$: More than 10000MΩ (GRM188R61C334-105K : 100Ω · F) $C > 0.047\mu F$: 500Ω · F C : Nominal Capacitance	The insulation resistance shall be measured with a DC voltage not exceeding the rated voltage at 25 °C and 75%RH max. and within 2 minutes of charging, provided the charge/discharge current is less than 50mA. * 5 minutes (GRM188R6/334-105K)										
7	Capacitance	Within the specified tolerance.	The capacitance/D.F. shall be measured at 25 °C at the frequency and voltage shown in the table.										
8	Q/Dissipation Factor (D.F.)	[R6,R7,C7] W.V.:100V :0.05max. W.V.:35/25/16V :0.035max. W.V.:10V :0.05max.(C< 3.3μF) :0.1max.(C ≥ 3.3μF) [F5] W.V.:50V :0.07max.(C < 0.1μF) :0.09max.(C ≥ 0.1μF) W.V.:35/25/16V :0.125max.	<table border="1"> <tr> <td>Char.</td> <td>R6,R7,F5,C7</td> </tr> <tr> <td>Item</td> <td></td> </tr> <tr> <td>Frequency</td> <td>1±0.1kHz</td> </tr> <tr> <td>Voltage</td> <td>1±0.2Vrms</td> </tr> </table>	Char.	R6,R7,F5,C7	Item		Frequency	1±0.1kHz	Voltage	1±0.2Vrms		
Char.	R6,R7,F5,C7												
Item													
Frequency	1±0.1kHz												
Voltage	1±0.2Vrms												
9	Capacitance Temperature Characteristics	R7 : Withn ±15% (-55°C to +125°C) R6 : Withn ±15% (-55°C to +85°C) F5 :Withn +22/-82% (-30°C to +85°C) C7 : Withn ±22% (-55°C to +125°C)	The capacitance change shall be measured after 5min. at each specified temp.stage. The ranges of capacitance change compared with the 25 °C value over the temperature ranges shown in the table shall be within the specified ranges.* <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>25±2</td> </tr> <tr> <td>2</td> <td>-55±3(for R6, R7,C7)/ -30±3(for F5)</td> </tr> <tr> <td>3</td> <td>25±2</td> </tr> <tr> <td>4</td> <td>125±3(forR7,C7)/ 85±3(for R6,F5)</td> </tr> </tbody> </table> <p>* Initial measurement for high dielectric constant type Perform a heat treatment at 150+0/-10°C for one hour and then set for 48±4 hours at room temperature. Perform the initial measurement.</p>	Step	Temperature(°C)	1	25±2	2	-55±3(for R6, R7,C7)/ -30±3(for F5)	3	25±2	4	125±3(forR7,C7)/ 85±3(for R6,F5)
Step	Temperature(°C)												
1	25±2												
2	-55±3(for R6, R7,C7)/ -30±3(for F5)												
3	25±2												
4	125±3(forR7,C7)/ 85±3(for R6,F5)												
10	Adhesive Strength of Termination	No removal of the terminations or other defect shall occur.	Solder the capacitor on the test jig (glass epoxy board) shown in Fig.1a using a n eutectic solder. Then apply * 10N force in parallel with the test jig for 10± 1sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. *5N (GRP/M15, GRM18) 2N (GRP/M03)										



Type	a	b	c
GRP/M03	0.3	0.9	0.3
GRP/M15	0.4	1.5	0.5
GRM18	1.0	3.0	1.2
GRM21	1.2	4.0	1.65
GRM31	2.2	5.0	2.0
GRM32	2.2	5.0	2.9
GRM43	3.5	7.0	3.7
GRM55	4.5	8.0	5.6

(in:mm)

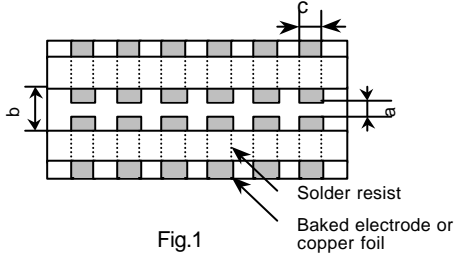
No	Item	Specification	Test Method																																				
11	Vibration Resistance	Appearance No defects or abnormalities.	Solder the capacitor on the test jig (glass epoxy board) in the same manner and under the same conditions as (10). The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours).																																				
	Capacitance	Within the specified tolerance.																																					
12	Deflection	Q/D.F. [R6,R7,C7] W.V.:100V :0.05max. W.V.:35/25/16V :0.035max. W.V.:10V :0.05max. (C < 3.3μF) :0.1max. (C ≥ 3.3μF) [F5] W.V.:50V :0.07max. (C < 0.1μF) :0.09max. (C ≥ 0.1μF) W.V.:35/25/16V :0.125max.	Solder the capacitor on the test jig (glass epoxy board) shown in Fig.2a using an eutectic solder. Then apply a force in the direction shown in Fig 3a for 5±1 sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.																																				
		No crack or marked defect shall occur.																																					
																																							
			<p>(GRP/M03,GRP/M15:0.8mm)</p> <table border="1"> <thead> <tr> <th>Type</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>GRP/M03</td> <td>0.3</td> <td>0.9</td> <td>0.3</td> </tr> <tr> <td>GRP/M15</td> <td>0.4</td> <td>1.5</td> <td>0.5</td> </tr> <tr> <td>GRM18</td> <td>1.0</td> <td>3.0</td> <td>1.2</td> </tr> <tr> <td>GRM21</td> <td>1.2</td> <td>4.0</td> <td>1.65</td> </tr> <tr> <td>GRM31</td> <td>2.2</td> <td>5.0</td> <td>2.0</td> </tr> <tr> <td>GRM32</td> <td>2.2</td> <td>5.0</td> <td>2.9</td> </tr> <tr> <td>GRM43</td> <td>3.5</td> <td>7.0</td> <td>3.7</td> </tr> <tr> <td>GRM55</td> <td>4.5</td> <td>8.0</td> <td>5.6</td> </tr> </tbody> </table> <p>(in mm)</p>	Type	a	b	c	GRP/M03	0.3	0.9	0.3	GRP/M15	0.4	1.5	0.5	GRM18	1.0	3.0	1.2	GRM21	1.2	4.0	1.65	GRM31	2.2	5.0	2.0	GRM32	2.2	5.0	2.9	GRM43	3.5	7.0	3.7	GRM55	4.5	8.0	5.6
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GRM55	4.5	8.0	5.6																																				
13	Solderability of Termination	75% of the terminations is to be soldered evenly and continuously.	Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion) . Preheat at 80 to 120 °C for 10-to 30 seconds. After preheating, immerse in an eutectic solder solution for 2±0.5 seconds at 230±5°C.																																				
14	Resistance to Soldering Heat	The measured and observed characteristics shall satisfy the specifications in the following table.	Preheat the capacitor at 120 to 150 °C for 1 minute. Immerse the capacitor in a eutectic solder solution at 270±5°C for 10±0.5 seconds. Set at room temperature for 48± 4 hours (high dielectric constant type), then measure. Initial measurement for high dielectric constant type Perform a heat treatment at 150 +0/-10°C for one hour and then set at room temperature for 48± 4 hours. Perform the initial measurement. *Preheating for GRM32/43/55																																				
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■ SPECIFICATIONS AND TEST METHODS

No	Item	Specification	Test Method
15	Temperature Cycle	The measured and observed characteristics shall satisfy the specifications in the following table.	Fix the capacitor to the supporting jig in the same manner and under the same conditions as (10). Perform the five cycles according to the four heat treatments shown in the following table. Set for or 48±4 hours (high dielectric constant type) at room temperature, then measure.
	Appearance	No defects or abnormalities.	
	Capacitance Change	R6,R7,C7 :Within ±7.5% F5 :Within ±20%	
	Q/D.F.	[R6,R7,C7] W.V.:100V :0.05max W.V.:35/25/16V :0.035max. W.V.:10V :0.05max.(C< 3.3μF) :0.1max.(C ≥ 3.3F) [F5] W.V.:50V :0.07max.(C < 0.1μF) :0.09max.(C ≥ 0.1μF) W.V.:35/25/16Vmax.:0.125max.	
	I.R.	More than 10,000MΩ or 500Ω · F (Whichever is smaller)	
	Dielectric Strength	No defects .	
16	Humidity (Steady State)	The measured and observed characteristics shall satisfy the specifications in the following table.	Sit the capacitor at 40± 2°C and in 90 to 95% humidity for 500±12 hours. Remove and set for 48± 4 hours at room temperature, then measure.
	Appearance	No defects or abnormalities.	
	Capacitance Change	R6,R7,C7:Within ±12.5% F5 :Within ±30%	
	Q/D.F.	[R6,R7,C7] W.V.:100V :0.075max W.V.:35/25/16V :0.05max. W.V.:10V:0.075max(C< 3.3μF) :0.125max.(C ≥ 3.3μF) [F5] W.V.:50V :0.1max.(C < 0.1μF) :0.125max.(C ≥ 0.1μF) W.V.:35/25/16V.:0.15max.	
	I.R.	More than 1,000MΩ or 500Ω · F (Whichever is smaller)	
	Dielectric Strength	No defects .	
17	Humidity Load	The measured and observed characteristics shall satisfy the specifications in the following table.	Apply the rated voltage * at 40±2°C and 90 to 95% humidity for 500±12 hours. Remove and set for 48±4 hours at room temperature, then measure. The charge/discharge current is less than 50mA. *GRM188R61A105K.6.3V · Initial measurement for F 5 / 25Vmax. Apply the rated DC voltage for 1 hour at 40± 2°C. Remove and set for 48±4 hours at room temperature. Perform initial measurement.
	Appearance	No defects or abnormalities.	
	Capacitance Change	R6,F7,C7:Within ±12.5% F5 :Within ±30%	
	Q/D.F.	[R6,R7,C7] W.V.:100V :0.075max W.V.:35/25/16V :0.05max. W.V.:10V:0.075max(C< 3.3μF) :0.125max.(C ≥ 3.3μF) [F5] W.V.:50V :0.1max.(C < 0.1μF) :0.125max.(C ≥ 0.1μF) W.V.:35/25/16Vmax.:0.15max.	
	I.R.	More than 500MΩ or 25Ω · F (Whichever is smaller)	
	Dielectric Strength	No defects .	
18	High Temperature Load	The measured and observed characteristics shall satisfy the specifications in the following table.	Apply 125% of the rated voltage at the maximum operating temperature ±3°C for 1000±12 hours. Set for or 48±4 hours (high dielectric constant type) at room Temperature, then measure. The charge/discharge current is less than 50mA. · Initial measurement for high dielectric constant type. Apply 125% of the rated DC voltage at the maximum operating temperature ± 3°C for one hour. Remove and set for 48±4 hours at room temperature. Perform initial measurement.
	Appearance	No defects or abnormalities.	
	Capacitance Change	R6,R7,C7:Within ±12.5% F5 :Within ±30%[Except 25Vmax and C ≥ 1.0. μF]	
	Q/D.F.	[R6,R7,C7] W.V.:100V :0.075max W.V.:35/25/16V :0.05max. W.V.:10V:0.075max(C< 3.3μF) :0.125max.(C ≥ 3.3μF) [F5] W.V.:50V :0.1max.(C < 0.1μF) :0.125max.(C ≥ 0.1μF) W.V.:35/25/16Vmax.:0.15max.	
	I.R.	More than 1,000MΩ or 500Ω · F (Whichever is smaller)	
	Dielectric Strength	No defects .	

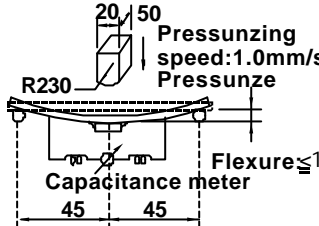
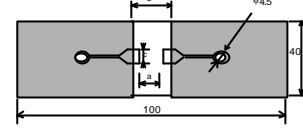
SPECIFICATION S AND TEST METHODS

P 20

No	Item	Specification	Test Method																																				
1	Operating Temperature Range	R6: -55°C to +85°C																																					
2	Rated Voltage	See the previous pages.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V^{P-P} or V^{O-P} , whichever is larger, shall be maintained within the rated voltage range.																																				
3	Appearance	No defects or abnormalities.	Visual inspection.																																				
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5	Dielectric Strength	No defects or abnormalities.	No failure shall be observed when 250% of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.																																				
6	Insulation Resistance	50Ω· F min.	The insulation resistance shall be measured with a DC voltage not exceeding the rated voltage at 25 °C and 75%RH max. and within 1 minutes of charging.																																				
7	Capacitance	Within the specified tolerance.	The capacitance/D.F. shall be measured at 25 °C at the frequency and voltage shown in the table.																																				
8	Dissipation Factor (D.F.)	0.125 max.	<table border="1"> <thead> <tr> <th>Capacitance</th> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>$C \leq 10\mu\text{F}$ (10V min.)</td> <td>$1 \pm 0.1\text{kHz}$</td> <td>$1.0 \pm 0.2 \text{ Vrms}$</td> </tr> <tr> <td>$C \leq 10\mu\text{F}$ (6.3V max.)</td> <td>$1 \pm 0.1\text{kHz}$</td> <td>$0.5 \pm 0.1 \text{ Vrms}$</td> </tr> <tr> <td>$C > 10\mu\text{F}$</td> <td>$120 \pm 24\text{Hz}$</td> <td>$0.5 \pm 0.1 \text{ Vrms}$</td> </tr> </tbody> </table>	Capacitance	Frequency	Voltage	$C \leq 10\mu\text{F}$ (10V min.)	$1 \pm 0.1\text{kHz}$	$1.0 \pm 0.2 \text{ Vrms}$	$C \leq 10\mu\text{F}$ (6.3V max.)	$1 \pm 0.1\text{kHz}$	$0.5 \pm 0.1 \text{ Vrms}$	$C > 10\mu\text{F}$	$120 \pm 24\text{Hz}$	$0.5 \pm 0.1 \text{ Vrms}$																								
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9	Capacitance Temperature Characteristics	<table border="1"> <thead> <tr> <th>Char.</th> <th>Temp.Range</th> <th>Referenc e Temp.</th> <th>Cap.Change</th> </tr> </thead> <tbody> <tr> <td>R6</td> <td>-55°C to +85°C</td> <td>25°C</td> <td>Within ±15%</td> </tr> </tbody> </table>	Char.	Temp.Range	Referenc e Temp.	Cap.Change	R6	-55°C to +85°C	25°C	Within ±15%	The capacitance change shall be measured after 5 min.at each specified temperature stage. The ranges of capacitance change compared with the 25 °C value over the temperature ranges shown in the table shall be within the specified ranges.																												
Char.	Temp.Range	Referenc e Temp.	Cap.Change																																				
R6	-55°C to +85°C	25°C	Within ±15%																																				
10	Adhesive Strength of Termination	No removal of the terminations or other defects shall occur.  <p align="center">Fig.1</p>	Solder the capacitor to the test jig (glass epoxy board) shown in Fig.1 using a eutectic solder. Then apply *10N force in parallel with the test jig for 10±1 sec. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. *5N (GR□15, GRM18)/2N (GR□03) <table border="1"> <thead> <tr> <th>Type</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>GR□03</td> <td>0.3</td> <td>0.9</td> <td>0.3</td> </tr> <tr> <td>GR□15</td> <td>0.4</td> <td>1.5</td> <td>0.5</td> </tr> <tr> <td>GRM18</td> <td>1.0</td> <td>3.0</td> <td>1.2</td> </tr> <tr> <td>GRM21</td> <td>1.2</td> <td>4.0</td> <td>1.65</td> </tr> <tr> <td>GRM31</td> <td>2.2</td> <td>5.0</td> <td>2.0</td> </tr> <tr> <td>GRM32</td> <td>2.2</td> <td>5.0</td> <td>2.9</td> </tr> <tr> <td>GRM43</td> <td>3.5</td> <td>7.0</td> <td>3.7</td> </tr> <tr> <td>GRM55</td> <td>4.5</td> <td>8.0</td> <td>5.6</td> </tr> </tbody> </table> <p align="right">(in mm)</p>	Type	a	b	c	GR□03	0.3	0.9	0.3	GR□15	0.4	1.5	0.5	GRM18	1.0	3.0	1.2	GRM21	1.2	4.0	1.65	GRM31	2.2	5.0	2.0	GRM32	2.2	5.0	2.9	GRM43	3.5	7.0	3.7	GRM55	4.5	8.0	5.6
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11	Vibration	<table border="1"> <tbody> <tr> <td>Appearance</td> <td>No defects or abnormalities.</td> </tr> <tr> <td>Capacitance</td> <td>Within the specified tolerance.</td> </tr> <tr> <td>D.F</td> <td>0.125 max.</td> </tr> </tbody> </table>	Appearance	No defects or abnormalities.	Capacitance	Within the specified tolerance.	D.F	0.125 max.	Solder the capacitor to the test jig (glass epoxy board) in the same manner and under the same conditions as (10). The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours).																														
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SPECIFICATIONS AND TEST METHODS

P 21

No	Item	Specification	Test Method																																				
12	Deflection	<p>No cracking or marking defects shall occur.</p>  <p>Fig.3</p>  <p>Fig.2</p>	<p>Solder the capacitor to the test jig (glass epoxy board) shown in Fig.2 using a eutectic solder. Then apply a force in the direction shown in Fig.3. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p> <table border="1" data-bbox="1053 291 1516 571"> <thead> <tr> <th>Type</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>GR□03</td> <td>0.3</td> <td>0.9</td> <td>0.3</td> </tr> <tr> <td>GR□15</td> <td>0.4</td> <td>1.5</td> <td>0.5</td> </tr> <tr> <td>GRM18</td> <td>1.0</td> <td>3.0</td> <td>1.2</td> </tr> <tr> <td>GRM21</td> <td>1.2</td> <td>4.0</td> <td>1.65</td> </tr> <tr> <td>GRM31</td> <td>2.2</td> <td>5.0</td> <td>2.0</td> </tr> <tr> <td>GRM32</td> <td>2.2</td> <td>5.0</td> <td>2.9</td> </tr> <tr> <td>GRM43</td> <td>3.5</td> <td>7.0</td> <td>3.7</td> </tr> <tr> <td>GRM55</td> <td>4.5</td> <td>8.0</td> <td>5.6</td> </tr> </tbody> </table> <p align="right">(in:mm)</p>	Type	a	b	c	GR□03	0.3	0.9	0.3	GR□15	0.4	1.5	0.5	GRM18	1.0	3.0	1.2	GRM21	1.2	4.0	1.65	GRM31	2.2	5.0	2.0	GRM32	2.2	5.0	2.9	GRM43	3.5	7.0	3.7	GRM55	4.5	8.0	5.6
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13	Solderability of Termination	75% of the terminations is to be soldered evenly and continuously.	<p>Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion). Preheat at 80 to 120 °C for 10 to 30 seconds. After preheating, immerse in eutectic solder solution for 2 ± 0.5 seconds at 230 ± 5 °C.</p>																																				
14	Resistance to Soldering Heat	<table border="1"> <tr> <td>Appearance</td> <td>No marking defects.</td> </tr> <tr> <td>Capacitance Change</td> <td>R6 : Within ± 15%</td> </tr> <tr> <td>D.F.</td> <td>0.125 max.</td> </tr> <tr> <td>I.R.</td> <td>50Ω·F min.</td> </tr> <tr> <td>Dielectric Strength</td> <td>No failure</td> </tr> </table>	Appearance	No marking defects.	Capacitance Change	R6 : Within ± 15%	D.F.	0.125 max.	I.R.	50Ω·F min.	Dielectric Strength	No failure	<p>Preheat the capacitor at 120 to 150 °C for 1 minute. Immerse the capacitor in a eutectic solder solution at 270 ± 5 °C for 10 ± 0.5 seconds. Let sit at room temperature for 48 ± 4 hours, then measure.</p> <p>· Initial measurement Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature. Perform the initial measurement.</p>																										
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15	Temperature Sudden Change	<table border="1"> <tr> <td>Appearance</td> <td>No marking defects.</td> </tr> <tr> <td>Capacitance Change</td> <td>R6 : Within ± 7.5%</td> </tr> <tr> <td>D.F.</td> <td>0.125 max.</td> </tr> <tr> <td>I.R.</td> <td>50Ω·F min.</td> </tr> <tr> <td>Dielectric Strength</td> <td>No failure</td> </tr> </table>	Appearance	No marking defects.	Capacitance Change	R6 : Within ± 7.5%	D.F.	0.125 max.	I.R.	50Ω·F min.	Dielectric Strength	No failure	<p>Fix the capacitor to the supporting jig in the same manner and under the same conditions as (10). Perform the five cycles according to the four heat treatments listed in the following table. Let sit for 48 ± 4 hours at room temperature, then measure.</p> <table border="1" data-bbox="877 1131 1476 1288"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> </tr> </thead> <tbody> <tr> <td>Temp.(°C)</td> <td>Min. Operating Temp. ± 0/3</td> <td>Room Temp.</td> <td>Max. Operating Temp. ± 3/0</td> <td>Room Temp.</td> </tr> <tr> <td>Time(min.)</td> <td>30±3</td> <td>2 to 3</td> <td>30±3</td> <td>2 to 3</td> </tr> </tbody> </table> <p>· Initial measurement Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature. Perform the initial measurement.</p>	Step	1	2	3	4	Temp.(°C)	Min. Operating Temp. ± 0/3	Room Temp.	Max. Operating Temp. ± 3/0	Room Temp.	Time(min.)	30±3	2 to 3	30±3	2 to 3											
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16	High Temperature High Humidity (Steady)	<table border="1"> <tr> <td>Appearance</td> <td>No marking defects.</td> </tr> <tr> <td>Capacitance Change</td> <td>R6 : Within ± 12.5%</td> </tr> <tr> <td>D.F.</td> <td>0.25max.</td> </tr> <tr> <td>I.R.</td> <td>12.5Ω·F min.</td> </tr> <tr> <td>Dielectric Strength</td> <td>No failure</td> </tr> </table>	Appearance	No marking defects.	Capacitance Change	R6 : Within ± 12.5%	D.F.	0.25max.	I.R.	12.5Ω·F min.	Dielectric Strength	No failure	<p>Apply the rated voltage at 40 ± 2 °C and 90 to 95% humidity for 500 ± 12 hours. The charge/discharge current is less than 50mA.</p> <p>· Initial measurement Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature. Perform the initial measurement.</p> <p>· Measurement after test Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature, then measure</p>																										
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17	Durability	<table border="1"> <tr> <td>Appearance</td> <td>No marking defects.</td> </tr> <tr> <td>Capacitance Change</td> <td>R6 : Within ± 12.5%</td> </tr> <tr> <td>D.F.</td> <td>0.25max.</td> </tr> <tr> <td>I.R.</td> <td>25Ω·F min.</td> </tr> <tr> <td>Dielectric Strength</td> <td>No failure</td> </tr> </table>	Appearance	No marking defects.	Capacitance Change	R6 : Within ± 12.5%	D.F.	0.25max.	I.R.	25Ω·F min.	Dielectric Strength	No failure	<p>Apply 100% of the rated voltage for 1000 ± 12 hours at the maximum operating temperature ± 3 °C. The charge/ discharge current is less than 50mA.</p> <p>· Initial measurement Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature. Perform the initial measurement.</p> <p>· Measurement after test Perform a heat treatment at 150 ± 10 °C for one hour and then let sit for 48 ± 4 hours at room temperature, then measure</p>																										
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PACKAGING

GRP/M Type

There are three type of packaging for chip monolithic ceramic capacitor.

Please specify the packaging code.

1. Bulk Packaging(Packaging Code=B) : In a bag.

Minimum Quantity:1000(pcs./bag), Only GRM43S, GRM55E/F : 500(pcs./bag)

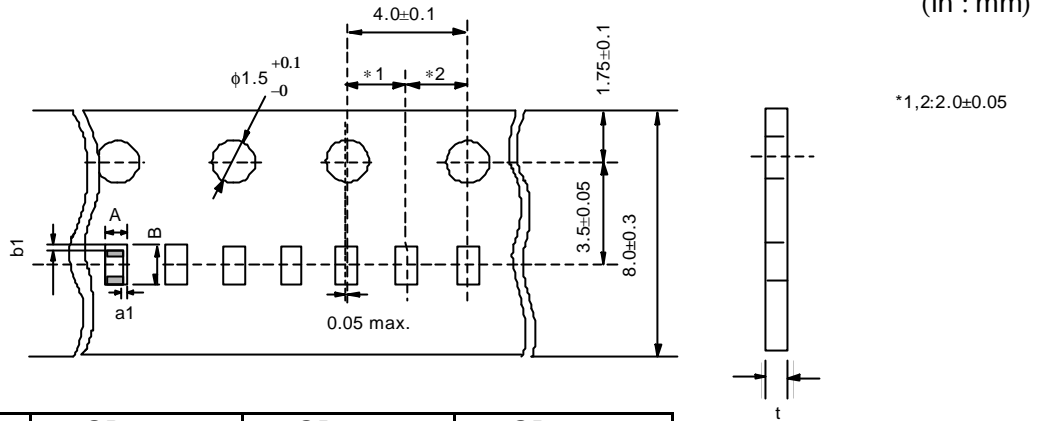
2. Tape Carrier Packaging(Packaging Code:D/E/F/L/J/K)

2.1 Minimum Quantity(pcs./reel)

Type	φ178 reel		φ330 reel	
	Paper Tape	Plastic Tape	Paper Tape	Plastic Tape
	Code:D/E	Code:L	Code:F/J	Code:K
GR□02	20000			
GR□03	15000		50000	
GR□15	10000		50000	
GR□18	4000		10000	
GR□21	5/6/9	4000	10000	
	A/B			10000
GR□31	6/9	4000	10000	
	M/X			10000
	C		2000	6000
GR□32	5/6/9	4000	10000	
	A/M			10000
	N			8000
	C			6000
	R/D/E		1000	4000
GR□43	M			5000
	N/C/R			4000
	D			4000
	E		500	2000
	S		500	1500
GR□55	M			5000
	N/C/R			4000
	D			4000
	E		500	
	F/X		300	1500

PACKAGING
GRP/M Type

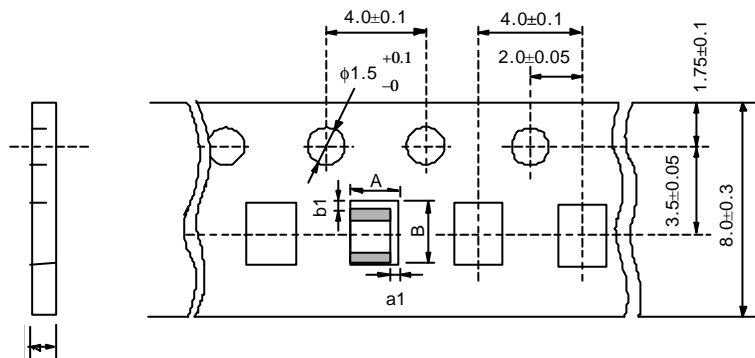
2.2 Dimensions of Tape
(1) GR □ 02/03/15



Code	GR □ 02	GR □ 03	GR □ 15
A *3	0.25	0.37	0.65
B *3	0.45	0.67	1.15
a1,b1*3	/		0.15
t	0.4 max.	0.5 max.	0.8 max.

*3 Nominal value

(2) GR □ 18/21/31/32 T:0.85 max.



0.8 max (T=0.5mm)
1.1 max (T≤0.85mm)

Code	GR □ 18	GR □ 21	GR □ 31	GR □ 32
A	1.05±0.1	1.55±0.15	2.0±0.2	2.8±0.2
B	1.85±0.1	2.3±0.15	3.6±0.2	3.6±0.2
a1,b1	0.25±0.2	0.4±0.2	0.4±0.2	0.4+0.3/-0.2

Fig.1 Package Chips

(in : mm)

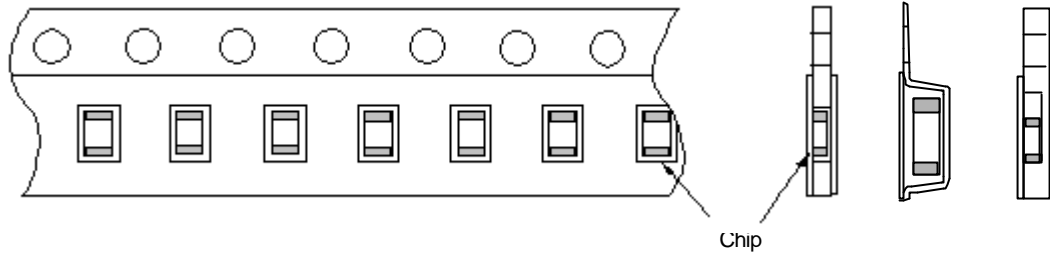


Fig.2 Dimensions of Reel

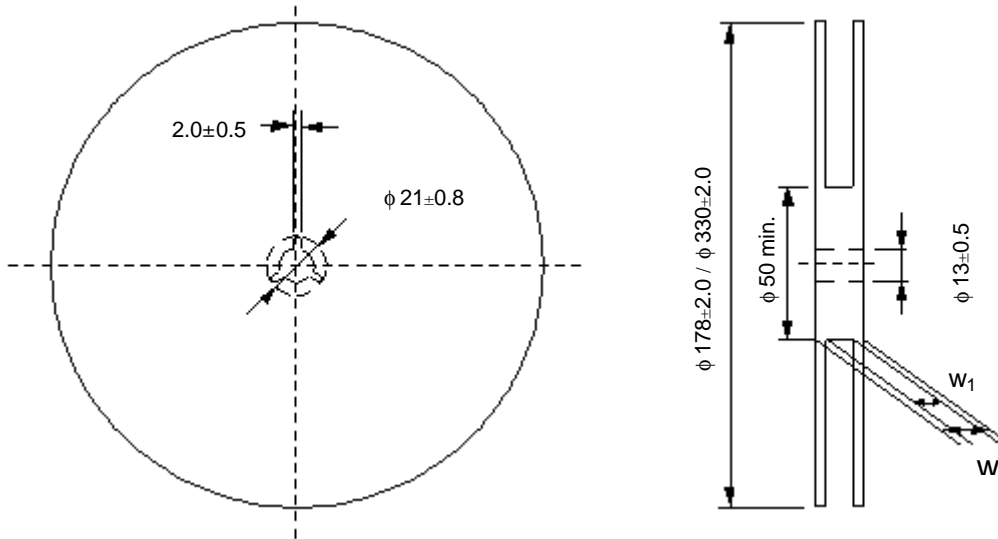
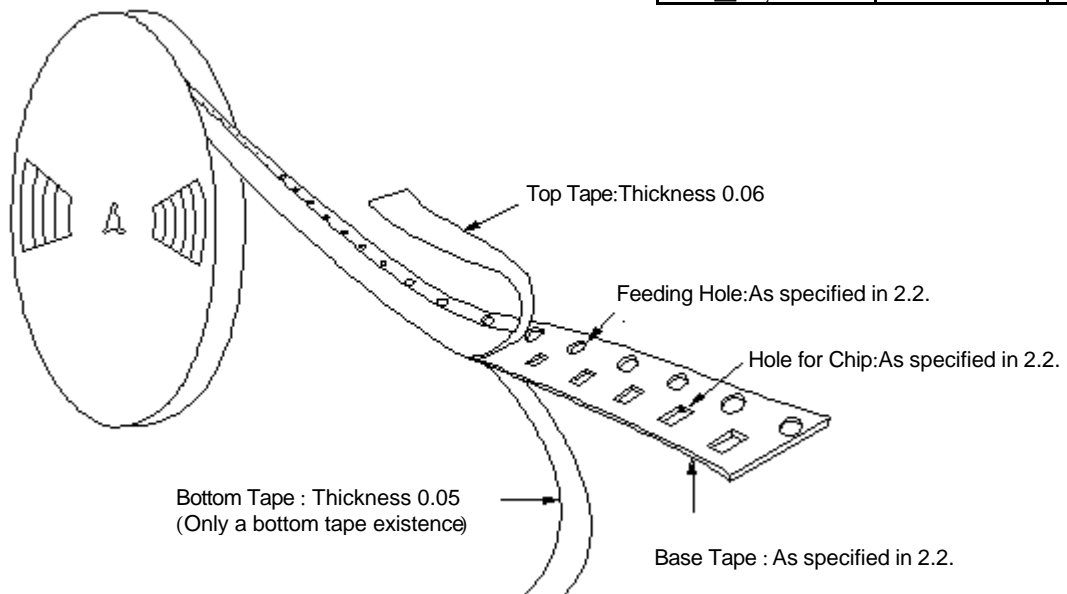


Fig.3 Taping Diagram

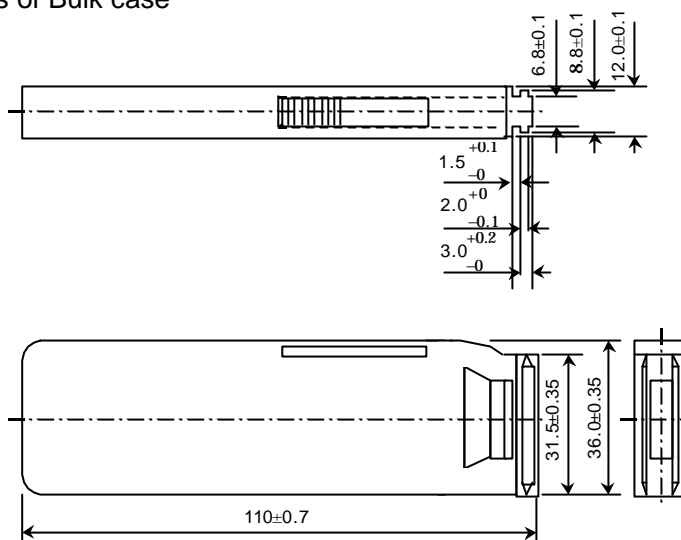
	W	w ₁
GR□32 max.	16.5 max.	10±1.5
GR□43, GRM55	20.5 max.	14±1.5



PACKAGING
GRP/M Type

3. Bulk Case Packaging (Packaging Code=C)

Fig.4 Dimensions of Bulk case



3.1 Minimum Quantity(pcs./case)

GR □15		50000
GR □18		15000
GR □21	6	10000
	B	5000

3.2 Case is made by resin of transparence or semitransparency, and appeaser and dimension is shown in Fig.4.

There are possibility to change the material and dimension due to some impairment.

3.3 Case must be marked in Customer 's part number, MURATA part number, MURATA name, Inspection number and quantity(pcs.).

⚠CAUTION**■Limitation of use**

Please contact our sales representatives or product engineers before using our products for the applications listed below which require of our products for other applications than specified in this product.

- ① Aircraft equipment ② Aerospace equipment ③ Undersea equipment ④ Power plant control equipment
 ⑤ Medical equipment ⑥ Transportation equipment(vehicles, trains, ships, etc.) ⑦ Traffic signal equipment
 ⑧ Disaster prevention / crime prevention equipment ⑨ Data-processing equipment
 ⑩ Application of similar complexity and/or requirements to the applications listed in the above

⚠CAUTION**■Storage and Operating Conditions**

Chip monolithic ceramic capacitors(chips) can experience degradation of termination solderability when subjected to high temperature or humidity, or if exposed to sulfur or chlorine gases.

Storage environment must be at an ambient temperature of 5-40 C. and an ambient humidity of 20-70%RH. Use chip within 6 months. If 6 months or more have elapsed, check solderability before use. (Reference Data 1/ Solderability)

Insulation Resistance shall be deteriorated on specific condition of high humidity or incorrosion gas such as hydrogen sulfide, sulfuric acid gas, chlorine. Those conditions are not suitable for use.

⚠CAUTION**■Handling****1. Inspection**

- Thrusting force of the test probe can flex the PCB, resulting in cracked chips or open solder joints. Provide support pins on the back side of the PCB to prevent warping or flexing.

2. Board Separation (or Depanelization)

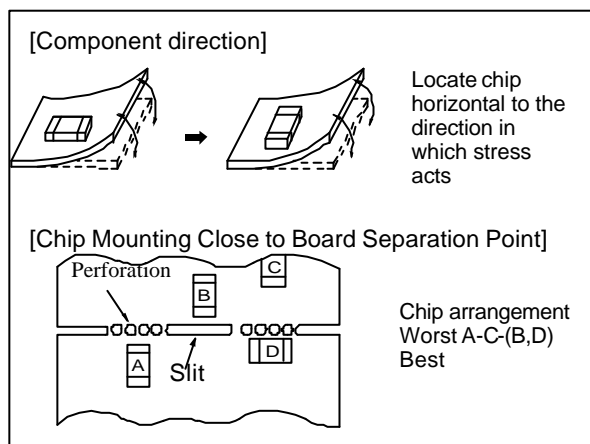
- Board flexing at the time of separation causes cracked chips or broken solder.
- Severity of stresses imposed on the chip at the time of board break is in the order of: Pushback < Slitter < V Slot < Perforator.
- Board separation must be performed using special jigs, not with hands.

3. Reel and bulk case

- In the handling of reel and case, please pay attention not to drop it. Please do not use chip of the case which dropped.

⚠CAUTION**■Soldering and Mounting****1. Mounting Position**

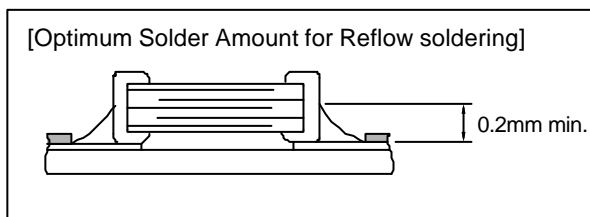
Choose a mounting position that minimizes the stress imposed on the chip during flexing or bending of the board.

**2. Solder Paste Printing**

- Overly thick application of solder paste results in excessive fillet height solder.

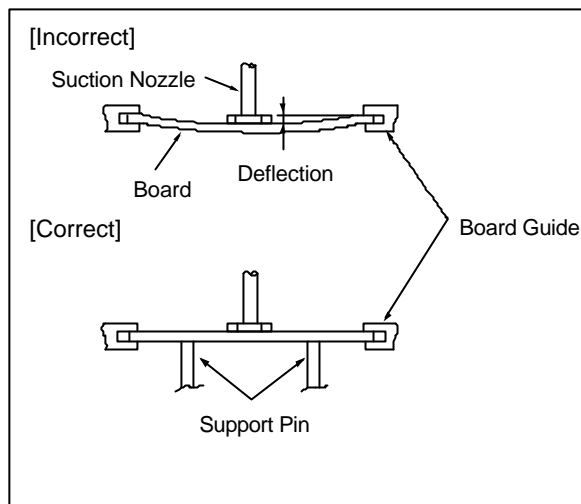
This makes the chip more susceptible to mechanical and thermal stress on the board and may cause cracked chips.

- Too little solder paste results in a lack of adhesive strength on the outer electrode, which may result in chips breaking loose from the PCB.
- Make sure the solder has been applied smoothly to the end surface to a height of 0.2mm min.



3. Chip Placing

- An excessively low bottom dead point of the suction nozzle imposes great force on the chip during mounting, causing cracked chips. So adjust the suction nozzle's bottom dead point by correcting warp in the board. Normally, the suction bottom dead point must be set on the upper surface of the board. Nozzle pressure for chip mounting must be a 1 to 3N static load.
- Dirt particles and dust accumulated between the suction nozzle and the cylinder inner wall prevent the nozzle from moving smoothly. This imposes great force on the chip during, causing cracked chips. And the locating claw, when worn out, imposes uneven forces on the chip when positioning, causing cracked chips. The suction nozzle and the locating claw must be maintained, checked and replaced periodically.



4. Reflow Soldering

- Sudden heating of the chip results in distortion due to excessive expansion and construction forces within the chip causing cracked chips. So when preheating, keep temperature differential, ΔT , within the range shown in Table 1. The smaller the ΔT , the less stress on the chip.
- Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.
- When components are immersed in solvent after mounting, be sure to maintain the temperature difference (ΔT) between the component and solvent within the range shown in the above table.

Table 1

Part Number	Temperature Differential
GR□02/03/15	$\Delta T \leq 190^\circ\text{C}$
GR□18/21/31	
GR□32/43/55	$\Delta T \leq 130^\circ\text{C}$

Inverting the PCB

Make sure not to impose an abnormal mechanical shock on the PCB.

[Standard Conditions for Reflow Soldering]

Infrared Reflow

The graph shows Temperature (°C) on the y-axis and Time on the x-axis. It includes a preheating phase with a temperature differential ΔT and a duration of 60 seconds min to 120 seconds max. The soldering phase is at 200°C for 20-40 seconds. The cooling phase is gradual cooling in the air.

Vapor Reflow

The graph shows Temperature (°C) on the y-axis and Time on the x-axis. It includes a preheating phase with a temperature differential ΔT and a duration of 60 seconds min to 120 seconds max. The soldering phase is for 20 seconds max. The cooling phase is gradual cooling in the air.

[Allowable Soldering Temperature and Time]

The graph plots Soldering temperature (°C) on the y-axis (220 to 280) against Soldering time (sec.) on the x-axis (0 to 120). A shaded area indicates the allowable range, which is constant at 270°C until 60 seconds, then decreases linearly to approximately 228°C at 90 seconds.

In case of repeated soldering, the accumulated Soldering time must be within the range shown above.

5. Leaded Component Insertion

If the PCB is flexed when leaded components (such as transformers and ICs) are being mounted, chips may crack and solder joints may break.

Before mounting leaded components, support the PCB using backup pins or special jigs prevent warping.

6. Flow Soldering

● Sudden heating of the chip results in thermal distortion causing cracked chips. And an excessively long soldering time or high soldering temperature results in leaching of the outer electrodes, causing poor adhesion or a reduction in capacitance value due to loss of contact between electrodes and end termination.

● When preheating, keep temperature differential between solder temperature and chip surface temperature, ΔT , within the range shown in Table 2. The smaller the ΔT , the less stress on the chip.

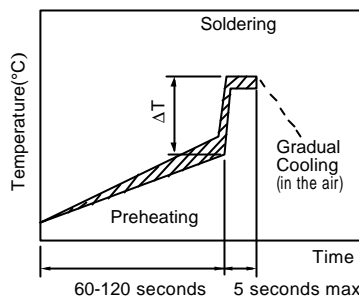
When components are immersed in solvent after mounting, be sure to maintain the temperature difference between the component and solvent within the range shown in Table 2.

Don't apply flow soldering to chips not listed in Table 2.

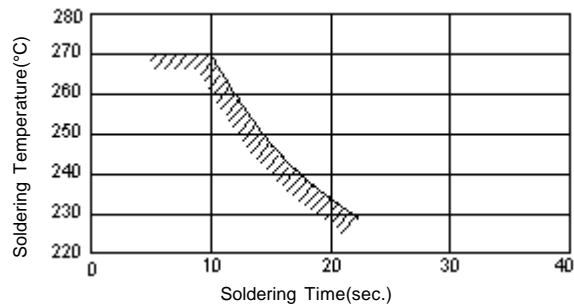
Table 2

Part Number	Temperature Differential
GR□18/21/31	$\Delta T \leq 150^{\circ}\text{C}$

[Standard Conditions for Flow Soldering]

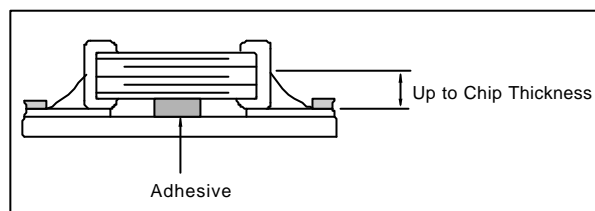


[Allowable Soldering Temperature and Time]



In case of repeated soldering, the accumulated soldering time must be within the range shown above.

● Optimum Solder Amount for Flow Soldering



7. Correction with a Soldering Iron

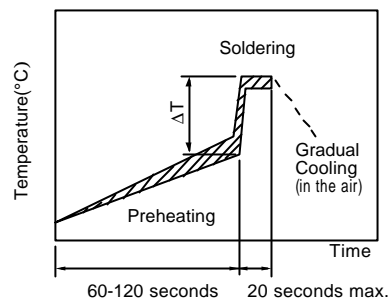
(1) For Chip Type Capacitors

- Sudden heating of the chip results in distortion due to a high internal temperature differential, causing cracked chips. When preheating, keep temperature differential, ΔT , within the range shown in Table 3. The smaller the ΔT , the less stress on the chip.

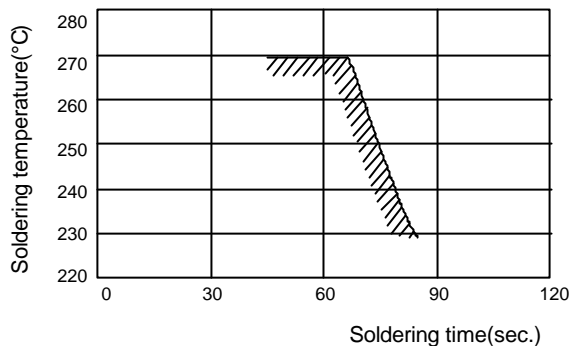
Table 3

Part Number	Temperature Differential
GR□03/15	$\Delta T \leq 190^{\circ}\text{C}$
GR□18/21/31	
GR□32/43/55	$\Delta T \leq 130^{\circ}\text{C}$

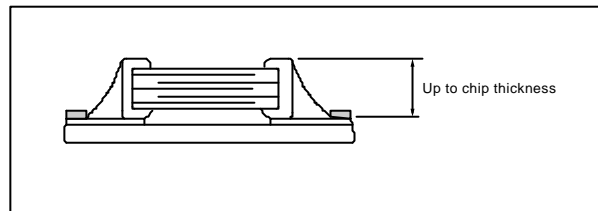
[Standard Conditions for Soldering Iron Temperature]



[Allowable time and Temperature for Making Corrections with a Soldering Iron]



- Optimum Solder Amount when Corrections Are Made Using a Soldering Iron



8. Washing

Excessive output of ultrasonic oscillation during cleaning causes PCBs to resonate, resulting in cracked chips or broken solder. Take note not to vibrate PCBs.

Failure to follow the above cautions may result, worst case, in a short circuit and fuming when the products is use.

NOTICE

■Soldering and Mounting

1.PCB Design

(1)Notice for Pattern Forms

Unlike leaded components, chip components are susceptible to flexing stresses since they are mounted directly on the substrate.

They are also more sensitive to mechanical and thermal stresses than leaded components.

Excess solder fillet height can multiply these stresses and cause chip cracking. When designing substrates, take land patterns and dimensions into consideration to eliminate the possibility of excess solder fillet height.

It has a possibility to happen the chip crack by the expansion and shrinkage of metal board. Please contact us if you want to use the ceramic capacitor on metal board such as Aluminum.

Pattern Forms

	Placing Close to Chassis	Placing of Chip Components and Leaded Components	Placing of Leaded Components after Chip Component	Lateral Mounting
Incorrect				
Correct				

(2)Land Dimensions

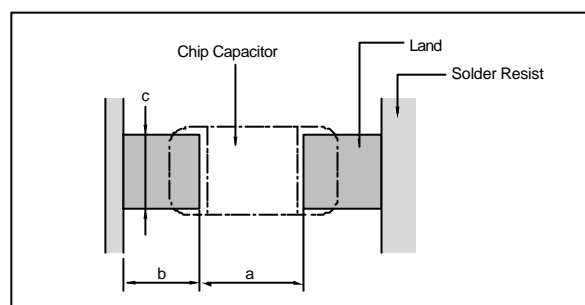


Table 1 Flow Soldering Method

Dimensions Part Number	Dimensions(L X W)	a	b	c
GR□18	1.6 X 0.8	0.6-1.0	0.8-0.9	0.6-0.8
GR□21	2.0 X 1.25	1.0-1.2	0.9-1.0	0.8-1.1
GR□31	3.2 X 1.6	2.2-2.6	1.0-1.1	1.0-1.4

(in : mm)

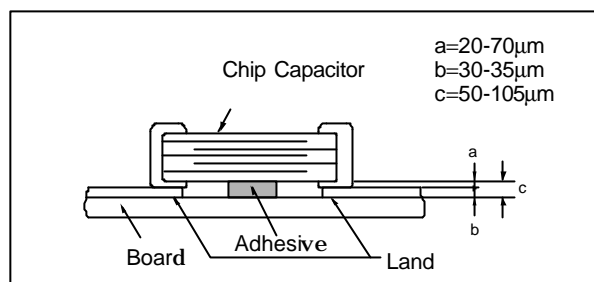
Table 2 Reflow Soldering Method

Dimensions Part Number	Dimensions(L X W)	a	b	c
GR□02	0.4 X 0.2	0.16-0.2	0.12-0.18	0.2-0.23
GR□03	0.6 X 0.3	0.2-0.3	0.2-0.35	0.2-0.4
GR□15	1.0 X 0.5	0.3-0.5	0.35-0.45	0.4-0.6
GR□18	1.6 X 0.8	0.6-0.8	0.6-0.7	0.6-0.8
GR□21	2.0 X 1.25	1.0-1.2	0.6-0.7	0.8-1.1
GR□31	3.2 X 1.6	2.2-2.4	0.8-0.9	1.0-1.4
GR□32	3.2 X 2.5	2.0-2.4	1.0-1.2	1.8-2.3
GR□43	4.5 X 3.2	3.0-3.5	1.2-1.4	2.3-3.0
GR□55	5.7 X 5.0	4.0-4.6	1.4-1.6	3.5-4.8

(in : mm)

2. Adhesive Application

- Thin or insufficient adhesive causes chips to loosen or become disconnected when flow soldered. The amount of adhesive must be more than dimension c shown in the drawing below to obtain enough bonding strength. The chip's electrode thickness and land thickness must be taken into consideration.
- Low viscosity adhesive causes chips to slip after mounting. Adhesive must have a viscosity of 5000pa-s(500ps) min. (at 25°C)



3. Adhesive Curing

Insufficient curing of the adhesive causes chips to disconnect during flow soldering and causes deteriorated insulation resistance between outer electrodes due to moisture absorption. Control curing temperature and time in order to prevent insufficient hardening.

Inverting the PCB

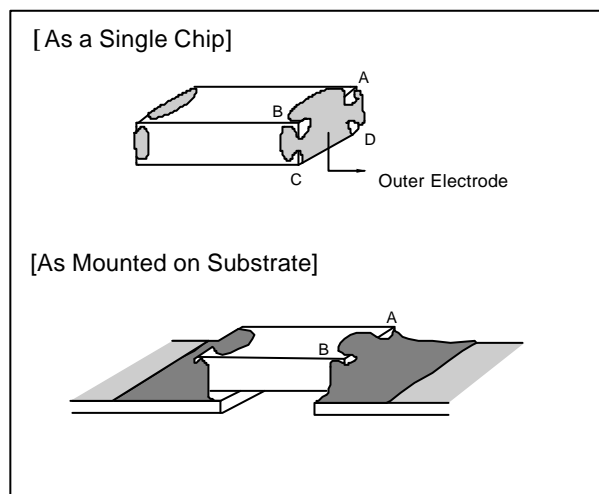
Make sure not to impose an abnormal mechanical shock on the PCB.

4. Flux Application

- An excessive amount of flux generates a large quantity of flux gas, causing deteriorated solderability. So apply flux thinly and evenly throughout. (A foaming system is generally used for flow soldering).
- Flux containing too high a percentage of halide may cause corrosion of the outer electrodes unless sufficiently cleaned. Use flux with a halide content of 0.2% max. But do not use strongly acidic flux. Wash thoroughly because water-soluble flux causes deteriorated insulation resistance between outer electrodes unless sufficiently cleaned.

5. Flow Soldering

- Set temperature and time to ensure that leaching of the outer electrode does not exceed 25% of the chip end area as a single chip (full length of the edge A-B-C-D shown below) and 25% of the length A-B shown below as mounted on substrate.



■Others**1.Resin Coating**

When selecting resin materials, select those with low contraction.

2.Circuit Design

These capacitors on this catalog are not safety recognized products.

3.Remarks

The above notices are for standard applications and conditions. Contact us when the products are used in special mounting conditions. Select optimum conditions for operation as they determine the reliability of the product after assembly.

⚠NOTE

1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2. You are requested not to use our product deviating from this product specification.
3. Please return one copy of these specifications upon your acceptance.
If the copy is not returned by a day mentioned in a cover the specifications will be deemed to have been accepted.
4. We consider it not appropriate to include any terms and conditions with regard to the business transaction in the product specifications, drawings or other technical documents. Therefore, if your technical documents as above include such terms and conditions such as warranty clause, product liability clause, or intellectual property infringement liability clause, they will be deemed to be invalid.

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